DATA SHEET

# μ**PD17215, 17216, 17217, 17218**

# 4-BIT SINGLE-CHIP MICROCONTROLLER FOR SMALL GENERAL-PURPOSE INFRARED REMOTE CONTROL TRANSMITTER

# DESCRIPTION

 $\mu$ PD17215, 17216, 17217, 17218 (hereafter called  $\mu$ PD17215 subseries) are 4-bit single-chip microcontrollers for small general-purpose infrared remote control transmitters.

It employs a 17K architecture of general-purpose register type devices for the CPU, and can directly execute operations between memories instead of the conventional method of executing operations through the accumulator. Moreover, all the instructions are 16-bit 1-word instructions which can be programmed efficiently.

In addition, a one-time PROM model,  $\mu$ PD17P218, to which data can be written only once, is also available. It is convenient either for evaluating the  $\mu$ PD17215 subseries programs or small-scale production of application systems.

Detailed functions are described in the follwing manual. Be sure to read this manual when designing your system.

### $\mu$ PD172×× Subseries User's Manual: U12795E

# **FEATURES**

- Infrared remote controller carrier generator circuit (REM output)
- 17K architecture: General-purpose register system
- Program memory (ROM), Data memory (RAM)

	μPD17215	μPD17216	μPD17217	μPD17218			
Program memory (ROM)	4 K bytes (2048 × 16)	8 K bytes (4096 × 16)	12 K bytes 16 K bytes (6144 × 16) (8192 × 16)				
Data memory (RAM)	111 ×	4 bits	223 ×	4 bits			

- 8-bit timer
- : 1 channel
- Basic internal timer / Watchdog timer: 1 channel (WDOUT output)
- Instruction execution time (can be changed in two steps)

at fx 4 MHz	:	4 $\mu$ s (high-speed mode)/8 $\mu$ s (ordinary mode)
at fx 8 MHz	:	2 $\mu$ s (high-speed mode)/4 $\mu$ s (ordinary mode)
External interrupt pin (INT)	:	1
I/O pins	:	20
Supply voltage	:	$V_{DD}$ = 2.2 to 5.5 V (at fx = 4 MHz (high-speed mode))
		$V_{DD}$ = 2.0 to 5.5 V (at fx = 4 MHz (ordinary mode))
		at fx 8 MHz : External interrupt pin (INT) : I/O pins :

• Low-voltage detector circuit (mask opation)

Unless otherwise specified, the  $\mu$ PD17215 is treated as the representative model throughout this document.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

# APPLICATION

Preset remote controllers, toys, portable systems, etc.

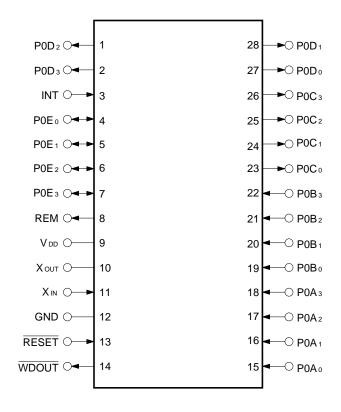
# ORDERING INFORMATION

Part Number	Package
μPD17215CT-xxx	28-pin plastic shrink DIP (400 mil)
$\mu$ PD17215GT-xxx	28-pin plastic SOP (375 mil)
$\mu$ PD17216CT-xxx	28-pin plastic shrink DIP (400 mil)
$\mu$ PD17216GT-xxx	28-pin plastic SOP (375 mil)
$\mu$ PD17217CT-xxx	28-pin plastic shrink DIP (400 mil)
$\mu$ PD17217GT-xxx	28-pin plastic SOP (375 mil)
$\mu$ PD17218CT-xxx	28-pin plastic shrink DIP (400 mil)
μPD17218GT-xxx	28-pin plastic SOP (375 mil)

**Remark:** xxx is ROM code number.

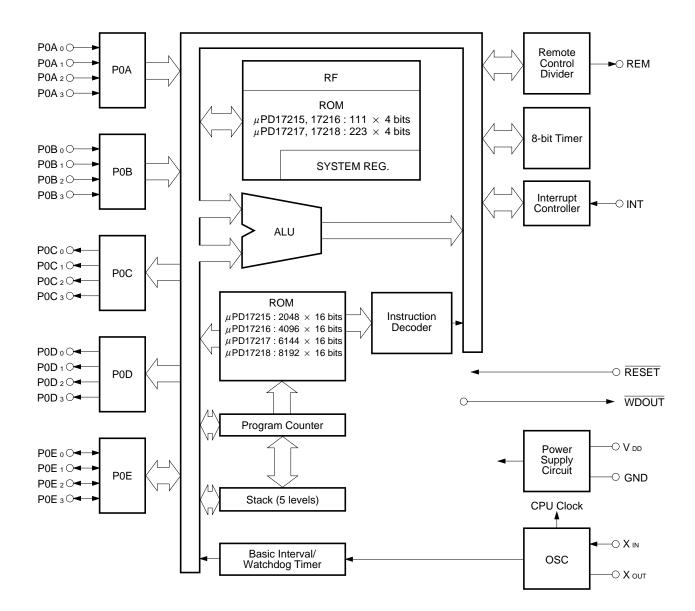
# PIN CONFIGURATION (TOP VIEW)

- 28-pin plastic SOP (375 mil) μPD17215GT-xxx, 17216GT-xxx, 17217GT-xxx, 17218GT-xxx
- 28-pin plastic shrink DIP (400 mil) μPD17215CT-xxx, 17216CT-xxx, 17217CT-xxx, 17218CT-xxx



INT:External interrupt request signal inputP0Ao-P0A3:Input port (CMOS input)P0Bo-P0B3:Input port (CMOS input)P0Co-P0C3:Output port (N-ch open-drain output)P0Do-P0D3:Output port (N-ch open-drain output)P0Eo-P0E3:I/O port (CMOS push-pull output)REM:Remote controller output (CMOS push-pull output)RESET:Reset inputVDD:Power supplyWDOUT:Hang-up/low voltage detection output (N-ch open-drain output)	GND	:	Ground
P0Bo-P0B3:Input port (CMOS input)P0Co-P0C3:Output port (N-ch open-drain output)P0Do-P0D3:Output port (N-ch open-drain output)P0Eo-P0E3:I/O port (CMOS push-pull output)REM:Remote controller output (CMOS push-pull output)RESET:Reset inputVDD:Power supplyWDOUT:Hang-up/low voltage detection output (N-ch open-drain output)	INT	:	External interrupt request signal input
P0Co-P0C3:Output port (N-ch open-drain output)P0Do-P0D3:Output port (N-ch open-drain output)P0Eo-P0E3:I/O port (CMOS push-pull output)REM:Remote controller output (CMOS push-pull output)RESET:Reset inputVob:Power supplyWDOUT:Hang-up/low voltage detection output (N-ch open-drain output)	P0A0-P0A3	:	Input port (CMOS input)
P0Do-P0D3:Output port (N-ch open-drain output)P0Eo-P0E3:I/O port (CMOS push-pull output)REM:Remote controller output (CMOS push-pull output)RESET:Reset inputVob:Power supplyWDOUT:Hang-up/low voltage detection output (N-ch open-drain output)	P0B0-P0B3	:	Input port (CMOS input)
P0Eo-P0E3:I/O port (CMOS push-pull output)REM:Remote controller output (CMOS push-pull output)RESET:Reset inputVDD:Power supplyWDOUT:Hang-up/low voltage detection output (N-ch open-drain output)	P0C0-P0C3	:	Output port (N-ch open-drain output)
REM       :       Remote controller output (CMOS push-pull output)         RESET       :       Reset input         Vbb       :       Power supply         WDOUT       :       Hang-up/low voltage detection output (N-ch open-drain output)	P0D0-P0D3	:	Output port (N-ch open-drain output)
RESET       : Reset input         Vbb       : Power supply         WDOUT       : Hang-up/low voltage detection output (N-ch open-drain output)	P0E0-P0E3	:	I/O port (CMOS push-pull output)
VDD       : Power supply         WDOUT       : Hang-up/low voltage detection output (N-ch open-drain output)	REM	:	Remote controller output (CMOS push-pull output)
WDOUT         : Hang-up/low voltage detection output (N-ch open-drain output)	RESET	:	Reset input
······································	Vdd	:	Power supply
XIN XOUT Connection	WDOUT	:	Hang-up/low voltage detection output (N-ch open-drain output)
	Xin, Xout	:	Oscillator connection

# **BLOCK DIAGRAM**



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# 1. PIN FUNCTIONS

# 1.1 Pin Function List

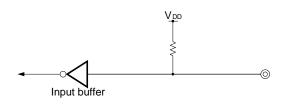
No.	Symbol	Function	Output Form	On Reset
15 16 17 18	P0A0 P0A1 P0A2 P0A3	4-bit CMOS input port with pull-up resistor. Can be used for key return input of key matrix. When at least one of these pins goes low, standby function is released.	-	Input
19 20 21 22	P0B0 P0B1 P0B2 P0B3	4-bit CMOS input port with pull-up resistor. Can be used for key return input of key matrix. When at least one of these pins goes low,standby function is released.	-	Input
23 24 25 26	P0C <sub>0</sub> P0C <sub>1</sub> P0C <sub>2</sub> P0C <sub>3</sub>	4-bit N-ch open-drain output port. Can be used for key source output of key matrix.	N-ch Open- drain	Low- level output
27 28 1 2	P0D0 P0D1 P0D2 P0D3	4-bit N-ch open-drain output port. Can be used for key source output of key matrix.	N-ch Open- drain	Low- level output
4 5 6 7	P0E0 P0E1 P0E2 P0E3	4-bit input/output port. Can be set in inputset in input or output mode in 1-bit units. In output mode, this port functions as a highcurrent CMOS output port. In input mode, function as CMOS input and can bespecified to connect pull-up resistor by program.	CMOS push- pull	Input
8	REM	Outputs transfer signal for infrared remotecontroller. Active-high output.	CMOS pusl-pll	Low-level output
13	RESET	System reset input. CPU can be reset when low-level signal is input to this pin. While low-level signal is input, oscillator circuit is stopped. Can be connected to pull-upresistor by mask option.	-	Input
9	Vdd	Power supply	-	-
12	GND	Ground	-	-
3	INT	External interrupt request signal input	-	Input
14	WDOUT	Output detecting hang-up and drop in supply voltage. This pin outputs at low level either when an overflow occurs in the watchdog timer, when an overflow/underflow occurs in the stack, or when the supply voltage drops below a specified level (mask option). Connect this pin to the RESET pin.	N-ch Open- drain	High- impedance Low-level output at low voltage detection
11 10	Xin Xout	Connects ceramic oscillator for system clock oscillation	-	(Oscillation stops)

# ★ 1.2 Input/Output Circuits

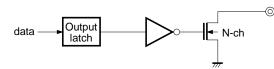
The equivalent input/output circuit for each  $\mu$ PD17215 pin is shown below.

### (1) P0A, P0B

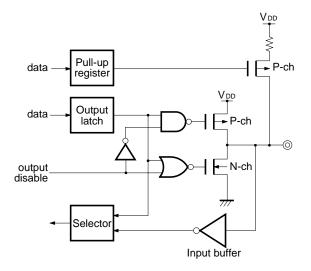
### (4) RESET

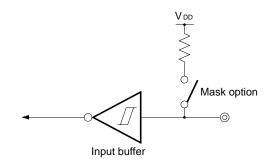


(2) P0C, P0D



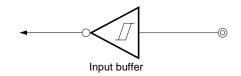






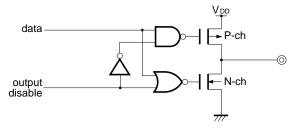
Schmitt trigger input with hysteresis characteristics

(5) INT

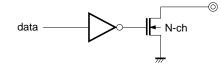


Schmitt trigger input with hysteresis characteristics

### (6) REM



(7) WDOUT



### 1.3 Processing of Unused Pins

Process the unused pins as follows:

Pin	Recommended Connection
P0A0-P0A3	Connect to VDD
P0B0-P0B3	Connect to VDD
P0C <sub>0</sub> -P0C <sub>3</sub>	Connect to GND
P0D <sub>0</sub> -P0D <sub>3</sub>	Connect to GND
P0E₀-P0E₃	Input : Connect to VDD or GND Output : Open
REM	Open
INT	Connect to GND
WDOUT	Connect to GND

Table 1-1	Processing	of	<b>Unused Pins</b>	
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### 1.4 Notes on Using INT and RESET Pins

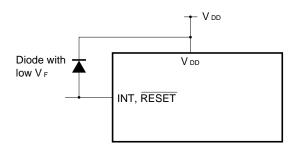
In addition to the functions shown in 1.1 PIN FUNCTIONS, the INT and  $\overrightarrow{\text{RESET}}$  pins also have a function to set a test mode (for IC testing) in which the internal operations of the  $\mu$ PD17215 are tested.

When a voltage higher than V<sub>DD</sub> is applied to either of these pins, the test mode is set. This means that, even during ordinary operation, the  $\mu$ PD17215 may be set in the test mode if a noise exceeding V<sub>DD</sub> is applied.

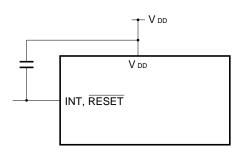
For example, if the wiring length of the INT or RESET pin is too long, noise superimposed on the wiring line of the pin main cause the above problem.

Therefore, keep the wiring length of these pins as short as possible to suppress the noise; otherwise, take noise preventive measures as shown below by using external components.

 Connect diode with low VF between VDD and INT/RESET pin



Connect capacitor between VDD and INT/RESET pin

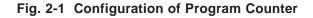


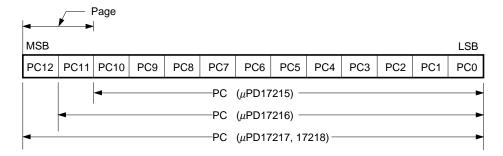
If the test mode is set by the INT pin, low level is output from the WDOUT pin. In this case, connect the WDOUT and RESET pin.

# 2. MEMORY SPACE

# 2.1 Program Counter (PC)

The program counter (PC) specifies an address of the program memory (ROM). The program counter is a 11/12/13-bit binary counter as shown in Fig. 2-1. Its contents are initialized to address 0000H at reset.





### 2.2 Program Memory (ROM)

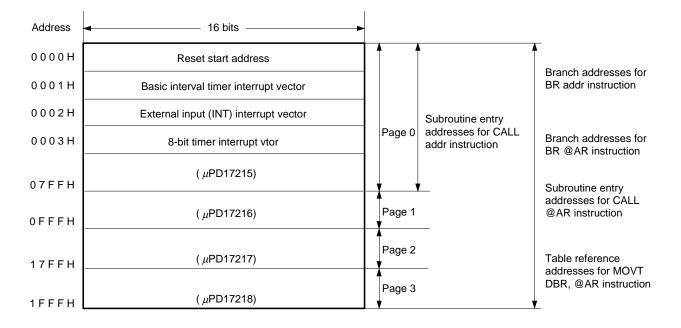
The configuration of the program memory is as follows:

Part Number	Capacity	Address
μPD17215	2048 x 16 bits	0000H-07FFH
μPD17216	4096 x 16 bits	0000H-0FFFH
μPD17217	6144 x 16 bits	0000H-17FFH
μPD17218	8192 x 16 bits	0000H-1FFFH

The program memory stores a program, interrupt vector table, and fixed data table.

The program memory is addressed by the program counter.

Fig. 2-2 shows the program memory map. The entire range of the program memory can be addressed by the BD addr, BR @AR, CALL @AR, MOVT DBF, and @AR instructions. Note, however, that the subroutine entry addresses that can be specified by the CALL addr instruction are from 0000H to 07FFH.



### Fig. 2-2 Program Memory Map

# 2.3 Stack

A stack is a register to save a program return address and the contents of system registers (to be described later) when a subroutine is called or when an interrupt is accepted.

### 2.3.1 Stack configuration

Fig. 2-3 shows the stack configuration.

A stack consists of a stack pointer (a 4-bit binary counter, the upper 1-bit fixed to 0), five 11-bit ( $\mu$ PD17215)/12-bit ( $\mu$ PD17216)/13-bit ( $\mu$ PD17217, 17218) address stack registers, and three 5-bit ( $\mu$ PD17215, 17216)/6-bit ( $\mu$ PD17217, 17218) interrupt stack registers.

Stack pointer (SP)				Address stack registers (ASR)														
bз	b2	b1	bo			<b>b</b> 12	b11	<b>b</b> 10	b9	b8	b7	b6	b5	b4	b3	b2	b1	bo
0	SPb2	SPb1	SPb0		► 0H					Ado	lress	stack	regist	ter 0				
					<b>→</b> 1H					Adc	lress	stack	regist	er 1				
					► 2H					Adc	Iress	stack	regist	er 2				
					<b>→</b> 3H					Adc	lress	stack	regist	er 3				
					<b>→</b> 4H					Adc	Iress	stack	regist	er 4				
					<b>→</b> 5H						U	ndefir	ed					
	WDOU when t		joes lov tents	^ ∫	<b>→</b> 6H						U	ndefir	ed					
	of the sare 6H		inter	J	<b>→</b> 7H						U	ndefir	ed					
								-			– μPl	D1721	5 —					•
							•				— <i>μ</i> Ρ[	01721	6 —					•
						✓ μPD17217, 17218												
										Inte		stack INTSI		ters				
						l	05		b4		bз		b2		bı		b	)
					0H	BAN	KSK0	BC	DSK0	C	MPSK	(0	CYSK	0	ZSK	0	IXES	SK0
	1H		1H	BAN	KSK1	BC	DSK1	C	CMPSK1		CYSK1		ZSK	1	IXES	SK1		
					2H	BAN	KSK2	BC	DSK2	: CI	MPSK	(2	CYSK	2	ZSK	2	IXES	SK2
│					– μPl	D1721	5, 172	16 —				-						
<b>Φ</b> PD17217, 17218								•										



### 2.3.2 Function of stack

The address stack register stores a return address when the subroutine call instruction or table reference instruction (first instruction cycle) is executed or when an interrupt is accepted. It also stores the contents of the address registers (ARs) when a stack manipulation instruction (PUSH AR) is executed.

### The WDOUT pin goes low if a subroutine call or interrupt exceeding 5 levels is executed.

The interrupt stack register (INTSK) saves the contents of the bank register (BANK) and program status word (PSWORD) when an interrupt is accepted. The saved contents are restored when an interrupt return (RETI) instruction is executed.

INTSK saves data each time an interrupt is accepted, but the data stored first is lost if more than 3 levels of interrupts occur.

### 2.3.3 Stack Pointer (SP) and Interrupt Stack Pointer

Table 2-1 shows the operations of the stack pointer (SP).

The stack pointer can take eight values, 0H-07. Because there are only five stack registers available, however, the WDOUT pin goes low if the value of SP is 6 or greater.

Instruction	Value of Stack Pointer (SP)	Counter of Interrupt Stack Register
CALL addr CALL @AR MOVT DBF, @AR (1st Instruction Cycle) PUSH AR	-1	0
When Interrupt Is Accepted	-1	-1
RET RETSK MOVT DBF, @AR (2nd Instruction Cycle) POP AR	+1	0
RET1	+1	+1

Table 2-1	Operations	of	Stack	Pointer
-----------	------------	----	-------	---------

### 2.4 Data Memory (RAM)

Data memory (random access memory) stores data for operations and control. It can be read-/write-accessed by instructions.

### 2.4.1 Memory configuration

Figure 2-4 shows the configuration of the data memory (RAM).

The data memory consists of two "banks": BANK0 and BANK1.

In each bank, every 4 bits of data is assigned an address. The higher 3 bits of the address indicate a "row address" and the lower 4 bits of the address indicate a "column address". For example, a data memory location indicated by row address 1H and column address 0AH is termed a data memory location at address 1AH. Each address stores data of 4 bits (= a "nibble").

In addition, the data memory is divided into following six functional blocks:

### (1) System register (SYSREG)

A system register (SYSREG) is resident on addresses 74H to 7FH (12 nibbles long) of each bank. In other nibbles, each bank has a system register at its addresses 74H to 7FH.

(2) Data buffer (DBF)

A data buffer is resident on addresses 0CH to 0FH (4 nibbles long) of bank 0 of data memory. The reset value is 0320H.

### (3) General register (GR)

A general register is resident on any row (16 nibbles long) of any bank of data memory. The row address of the general register is pointed by the general pointer (RP) in the system register (SYSREG).

### (4) Port register

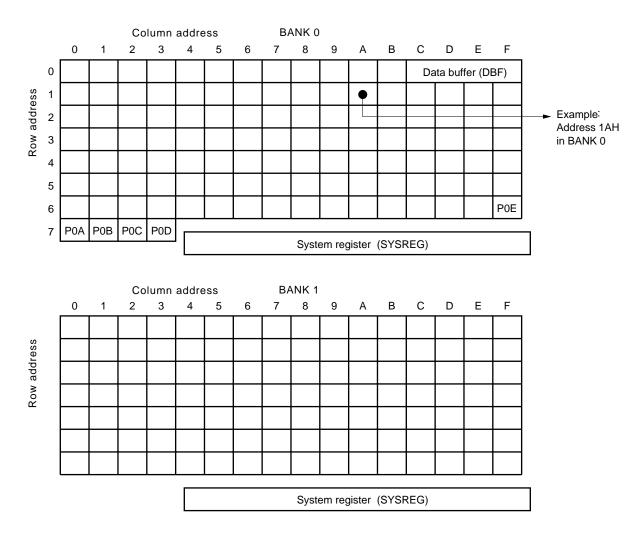
A port data register is resident on addresses 6FH, and 70H to 73H (5 nibbles) of BANK0 of data memory. No data can be written to the addresses 70H to 73H of BANK1 (the values of addresses 70H to 73H of BANK0 are read in this case).

 $\mu$ PD17215 and 17216 are not provided with BANK1.

### (5) General-purpose data memory

The general-purpose data memory area is an area of the data memory excluding the system register area, and the port register area. This memory area has a total of 223 nibbles (111 nibbles in BANK0 and 112 nibbles in BANK1).

 $\mu$ PD17215 and 17216 are not provided with BANK1.





Caution: No data can be written to the addresses 70H to 73H of BANK1 (the value of P0A to P0D are read in this case).

## 2.4.2 System registers (SYSREG)

The system registers are registers that are directly related to control of the CPU. These registers are mapped to addresses 74H-7FH on the data memory and can be referenced regardless of bank specification.

The system registers include the following registers:

Address registers (AR0-AR3)\* Window register (WR) Bank register (BANK)\* Memory pointer enable flag (MPE) Memory pointers (MPH, MPL) Index registers (IXH, IXM, IXL) General register pointers (RPH, RPL) Program status word (PSWORD)

\*: The address register (AR3) and the bank register (BANK) are fixed to 0 in the  $\mu$ PD17215 and 17216.

Address	74H	75H	76H	77H	78H	79H	7AH	7BH	7CH	7DH	7EH	7FH	
Name	Namo Address register				Window register			Index register (IX)			eral ter	Program status	
		(A	.R)	1	(WR)	0 0		ata memory w address pinter (MP)		point (RP)	er	word (PSWORD)	
Symbol	AR 3	AR 2	AR 1	AR 0	WR	BANK	IXH MPH	IXM MPL	IXL	RPH	RPL	PSW	
Bit	b3b2b1b	0 <b>b3b2b1b</b> 0	b3b2b1b0	b3b2b1b0	b3b2b1b0	b3b2b1b0	b3b2b1b0	b3b2b1b0	b3b2b1b0	b3b2b1b0	b3b2b1	b0b3b2b1b0	
Data	0 0 0 -		PD17217, (μPD172 (μPD172 (μPD172	216)	(WR)	(BANK) 0 0 0 ↔ *	M P 0 0 0 E	(I)	X)	000	(RP)	BCCI CMYZX DPE	
Initial Value At Reset	0 0 0 0	00000	0 0 0 0	0 0 0 0	Undefined	0 0 0 0	0 0 0 0	0 0 0 0	0000	0 0 0 0	0 0 0	0 0 0 0 0	

Fig. 2-5 Configuration of System Register

\*: This bit is fixed to 0 in the  $\mu$ PD17215 and 17216.

## 2.4.3 General register (GR)

A general register is a 16-word register on the data memory and used for arithmetic operations and transfer of data to and from the data memory.

# (1) Configuration of general register

Figure 2-6 shows the configuration of the general register.

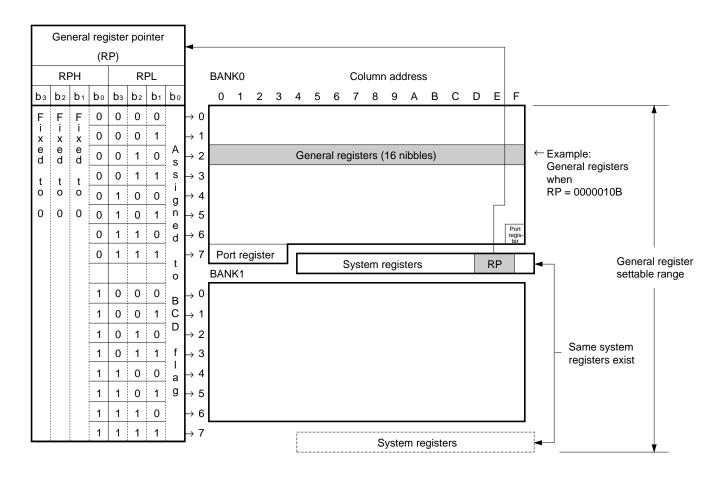
A general register occupies 16 nibbles (16 x 4 bits) on a selected row address of the data memory.

The row address is selected by the general register pointer (RP) of the system register. The RP having four significant bits in the  $\mu$ PD17217 and 17218 can point to any row address in the range of 0H to 7H of each bank (BANK0 and BANK1).

In the  $\mu$ PD17215 and 17216, 3 bits are available in the RP. These bits can point to any row address in the range of 0H to 7H of BANK0.

# (2) Functions of the general register

The general register enables an arithmetic operation and data transfer between the data memory and a selected general register by a single instruction. As a general register is a part of the data memory, you can say that the general register enables arithmetic operation and data transfer between two locations of the data memory. Similarly, the general register can be accessed by a Data Memory Manipulation instruction as it is a part of the data memory.



# Fig. 2-6 Configuration of General Registers

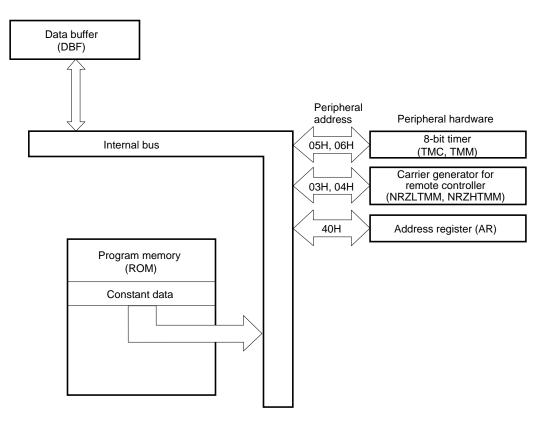
# 2.4.4 Data buffer (DBF)

The data buffer on the addresses 0CH to 0FH of data memory is used for data transfer to and from peripheral hardware and for storage of data during table reference.

### (1) Functions of the Data Buffer

The data buffer has two major functions: a function to transfer to and from hardware and a function to read constant data from the program memory (for table reference). Figure 2-7 shows the relationship between the data buffer and peripheral hardware.





Llandurana		Peripheral Regis	ster Transferring Da	ata with Data Buffe	er
Hardware Peripherals	Name	Symbol	Peripheral Address	Data Buffer	PUT/GET
9 Dit Timor	8-bit counter	TMC	05H	DBF0, DBF1	GET only
8-Bit Timer	8-bit modulo register	ТММ	06H	DBF0, DBF1	PUT only
Remote Controller	NRZ low level period setting modulo register	NRZLTMM	03H	DBF0, DBF1	PUT GET
Carrier Generator	NRZ high level period setting modulo register	NRZHTMM	04H	DBF0, DBF1	PUT (clear bit 3 of DBF1 to 0) GET (bits 3 of DBF1 is always 0)
Address Register	Address register	AR	40H	DBF0-DBF3	PUT (bits 0 to 3 of AR3 and bit 3 of AR2 are any)* <sup>1</sup> GET (bits 0 to 3 of AR3 and bit 3 of AR2 are always 0)* <sup>2</sup>

Table 2-2 Relations between Hardware Peripherals and Data Buffer

\*1: In the  $\mu$ PD17216: bits 0 to 3 of AR3 are any, in the  $\mu$ PD17217, 17218: bits 1 to 3 of AR3 are any

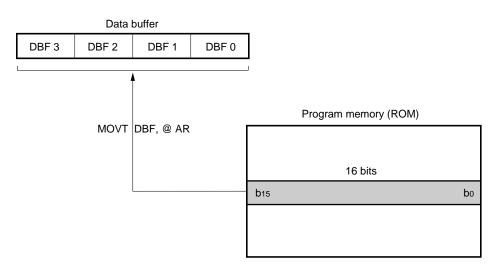
2: In the  $\mu$ PD17216: bits 0 to 3 of AR3 are always 0, in the  $\mu$ PD17217, 17218: bits 1 to 3 of AR3 are always 0

# (2) Table reference

A MOVT instruction reads constant data from a specified location of the program memory (ROM) and sets it in the data buffer.

The function of the MOVT instruction is explained below.

MOVT DBF,@AR: Reads data from a program memory location pointed to by the address register (AR) and sets it in the data buffer (DBF).



# (3) Note on using data buffer

When transferring data to/from the peripheral hardware via the data buffer, the unused peripheral addresses, write-only peripheral registers (only when executing PUT), and read-only peripheral registers (only when executing GET) must be handled as follows:

• When device operates

Nothing changes even if data is written to the read-only register.

If the unused address is read, an undefined value is read. Nothing changes even if data is written to that address.

• Using assembler

An error occurs if an instruction is executed to read a write-only register. Again, an error occurs if an instruction is executed to write data to a read-only register. An error also occurs if an instruction is executed to read or write an unused address.

• If an in-circuit emulator (IE-17K or IE-17K-ET) is used (when instruction is executed for patch processing) An undefined value is read if an attempt is made to read the data of a write-only register, but an error does not occur.

Nothing changes even if data is written to a read-only register, and an error does not occur. An undefined value is read if an unused address is read; nothing changes even if data is written to this address. An error does not occur.

### 2.5 Register File (RF)

The register file mainly consists of registers that set the conditions of the peripheral hardware.

These registers can be controlled by dedicated instructions PEEK and POKE, and the embedded macro instructions of AS17K, SETn, CLRn, and INITFLG.

### 2.5.1 Configuration of register file

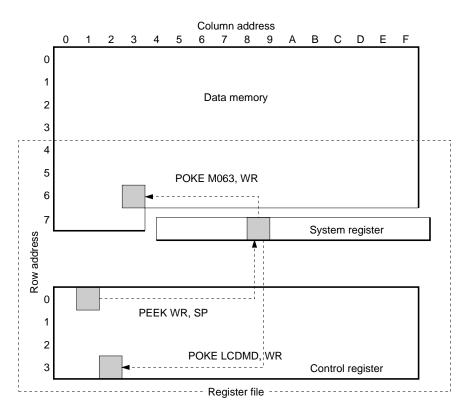
Fig. 2-8 shows the configuration of the register file and how the register file is accessed by the PEEK and POKE instructions.

The control registers are controlled by using dedicated instructions PEEK and POKE. Since the control registers are assigned to addresses 00H-3FH regardless of the bank, the addresses 00H-3FH of the general-purpose data memory cannot be accessed when the PEEK or POKE instruction is used.

The addresses that can be accessed by the PEEK and POKE instructions are the addresses 00H-3FH of the control registers and 40H-7FH of the general-purpose data memory. The register file consists of these addresses.

The control registers are assigned to addresses 80H-BFH on the IE-17K to facilitate debugging.

# Fig. 2-8 Register File Access with PEEK or POKE Instructions



### 2.5.2 Control registers

The control registers consists of a total of 64 nibbles (64 x 4 bits) of the addresses 00H-3FH of the register file.

Of these, however, only 14 nibbles are actually used. The remaining 50 nibbles are unused registers that are inhibited from being read or written.

When the "PEEK WR, rf" instruction is executed, the contents of the register file addressed by "rf" are read to the window register.

When the "POKE rf, WR" instruction is executed, the contents of the window register are written to the register file addressed by "rf".

When using the assembler (AS17K), the macro instructions listed below, which are embedded as flag type symbol manipulation instructions, can be used. The macro instructions allow the contents of the register file to be manipulated in bit units.

For the configuration of the control register, refer to Fig. 11-1 Register File List.

SETn:Sets flag to "1"CLRn:Sets flag to "0"SKTn:Skips if all flags are "1"SKFn:Skips if all flags are "0"NOTn:Complements flagINITFLG:Initializes flag

### 2.5.3 Notes on using register files

When using the register files, bear in mind the points described below. For details, refer to  $\mu$ PD172xx subseries User's Manual (IEU-1317).

(1) When manipulating control registers (read-only and unused registers)

When manipulating the write-only (W), the read-only (R) and unused control registers by using the assembler or in-circuit emulator, keep in mind the following points:

When device operates

Nothing changes even if data is written to the read-only register. If the unused register is read, an undefined value is read; nothing is changed even if data is written to this register.

• Using assembler

An error occurs if instruction is executed to read data to the write-only register. An error occurs if an instruction is executed to write data to the read-only register. An error also occurs if an instruction is executed to read or write the unused address.

 When an in-circuit emulator (IE-17K or IE-17K-ET) is used (when instruction is executed for patch processing)

An undefined value is read if the write-only register is read, and an error does not occur. Nothing changes even if data is written to the read-only register, and an error does not occur. An undefined value is read if the unused address is read; nothing changes even if data is written to this address. An error does not occur. (2) Symbol definition of register file

An error occurs if a register file address is directly specified as a numeral by the operand "rf" of the "PEEK WR, rf" or "POKE rf, WR" instruction if the 17K Series Assembler (AS17K) is being used.

Therefore, the addresses of the register file must be defined in advance as symbols.

To define the addresses of the control registers as symbols, define them as the addresses 80H-BFH of BANK0.

The portion of the register file overlapping the data memory (40H-7FH), however, can be defined as symbols as is.

# 3. PORTS

### 3.1 Port 0A (P0A<sub>0</sub>-P0A<sub>3</sub>)

This is a 4-bit input port. Data is read through port register P0A (address 70H). This port is a CMOS input port with a pull-up resistor, and can be used for key return input for a key matrix.

When a low-level signal is input to at least one of the pins in this port in the standby mode, the standby mode is released.

# 3.2 Port 0B (P0B<sub>0</sub>-P0B<sub>3</sub>)

This is a 4-bit input port. Data is read through port register P0B (address 71H). This port is a CMOS input port with a pull-up resistor, and can be used for key return input for a key matrix.

When a low-level signal is input to at least one of the pins in this port in the standby mode, the standby mode is released.

# 3.3 Port 0C (P0C0-P0C3)

This is a 4-bit output port. The contents of the output latch are read and output data is set through port register POC (address 72H). This port is an N-ch open-drain output port, and can be used as the key source of a key matrix. In the standby mode, this port outputs low-level signals.

# 3.4 Port 0D (P0D<sub>0</sub>-P0D<sub>3</sub>)

This is a 4-bit output port. The contents of the output latch are read and output data is set through port register P0D (address 73H). This port is an N-ch open-drain output port, and can be used as the key source for a key matrix. In the standby mode, this port outputs low-level signals.

# 3.5 Port 0E (P0E<sub>0</sub>-P0E<sub>3</sub>)

This is a 4-bit I/O port which can be set in either the input or output mode in 1-bit units by the P0EBIO (address 27H) of the register file.

To read the input data or to set the output data, use the P0E register (address 6F). When data is read in the output mode, the contents of the output latch are read.

Connection of a pull-up resistor can be specified in 1-bit units by the P0EBPU (address 17H) of the register file. (When the pull-up resistor is connected, note that the pull-up resistor is not disconnected even when the output mode is set.)

On reset, this port functions as an input port.

## 3.6 INT Pin

This pin inputs an external interrupt request signal. At either the rising or falling edge of the signal input to this pin, the IRQ flag (RF: address 3EH, bit 0) is set.

The status of this pin can be read by using the INT flag (RF: address 0FH, bit 0). When the high level is input to the pin, the INT flag is set to "1"; when the low level is input, the flag is reset to "0" (refer to 7.2.1 INT).

Denk	Address	Port		Bit	Output Form	Contents to	Be Read	Contents to	Be Written	On Reset	
Балк	Address	Pon		ы	Output Form	Input Mode	Output Mode	Input Mode	Output Mode	On Reset	
			bз	P0A <sub>3</sub>							
	70H	Port 0A	b2	P0A <sub>2</sub>							
	700	FUILUA	b₁	P0A <sub>1</sub>							
			b٥	P0A₀	Input only	Pin status				Input mode	
			bз	P0B₃		FIII Status				(w/pull-up resistor)	
	71H	Port 0B	b2	P0B <sub>2</sub>							
	/ 10	POR UB	b1	P0B1							
			b٥	P0B₀							
		Port 0C	bз	P0C <sub>3</sub>							
	72H		b2	P0C <sub>2</sub>						Output mode (Low level output)	
0	72H		b1	P0C1					Output latch		
			b٥	P0C <sub>0</sub>	N-ch						
			bз	P0D3	open-drain (Output only)						
	73H	Port 0D	b2	P0D <sub>2</sub>			Output				
	730	POILOD	b1	P0D1			latch		latch		
			b٥	P0D <sub>0</sub>							
			bз	P0E₃							
	6FH	Port 0E	b2	P0E <sub>2</sub>	COMS	Disatata		Output latch		Input mode	
	огп	FUILUE	b1	P0E <sub>1</sub>	push-pull	Pin status				(w/puİl-up resistor)	
			b٥	P0E₀							

### Fig. 3-1 Relations between Port Register and Each Pin

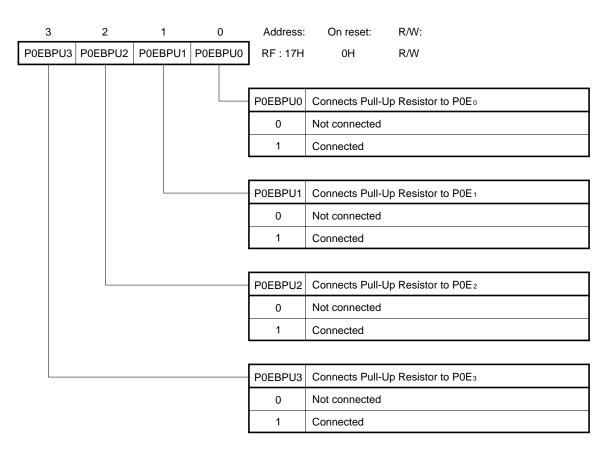
# 3.7 Switching Bit I/O

The I/O which can be set in the input or output mode in bit units is called a bit I/O. POE is a bit I/O port, which can be set in the input or output mode in bit units by the register file shown below. When the mode is changed from input to output, the POE output latch contents are output to the port lines, as soon as the mode has been changed.

3		2	2	1	l	0	Address:	On reset:	R/W:
P0EB	3103	P0EE	3102	POEE	3101	P0EBIO0	RF : 27H	0H	R/W
							P0EBIO0	Sets P0E0 Inp	but/Output Mode
							0	Sets P0E <sub>0</sub> in i	input mode
							1	Sets $POE_0$ in $c$	output mode
							P0EBIO1	Sets P0E1 Inp	put/Output Mode
							0	Sets P0E1 in i	input mode
							1	Sets P0E1 in o	output mode
							P0EBIO2	Sets P0E2 Inp	put/Output Mode
							0	Sets P0E2 in i	input mode
							1	Sets P0E <sub>2</sub> in a	output mode
L							P0EBIO3	Sets P0E₃ Inp	put/Output Mode
							0	Sets P0E₃ in i	input mode
							1	Sets P0E <sub>3</sub> in o	output mode

# 3.8 Specifying Pull-up Resistor Connection

Whether or not a pull-up resistor is connected to port P0E can be specified by the following registers of the register file in 1-bit units when the port is in the input mode\*.



\*: To disconnect the pull-up resistor in the output mode, clear the corresponding bit of the P0EBPU register.

# 4. CLOCK GENERATOR CIRCUIT

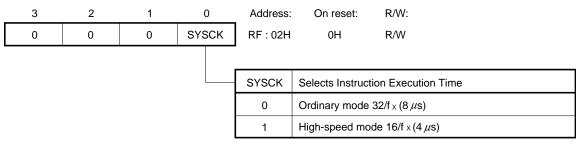
# 4.1 Instruction Execution Time (CPU Clock) Selection

The  $\mu$ PD17215 is equipped with a clock oscillator circuit that supplies clocks to the CPU and hardware peri-pherals. Instruction execution time can be changed in two steps (ordinary mode and high-speed mode) without changing the oscillation frequency.

To change the instruction execution time, change the mode of SYSCK (RF: address 02H) of the register file by using the POKE instruction.

Note, that the mode is actually only changed when the instruction next to the POKE instruction has been executed.

When using the high-speed mode, pay attention to the supply voltage. (Refer to **13. ELECTRICAL SPECIFICATIONS**.) At reset, the ordinary mode is set.



Figures in ( ): indicate figures when system clock f x= 4 MHz.

# 5. 8-BIT TIMER AND REMOTE CONTROLLER CARRIER GENERATOR CIRCUIT

The  $\mu$ PD17215 is equipped with the 8-bit timer which is mainly used to generate the leader pulse of the remote controller signal, and to output codes.

### 5.1 Configuration of 8-bit Timer (with modulo function)

Figure 5-1 shows the configuration of the 8-bit timer.

As shown in this figure, the 8-bit timer consists of an 8-bit counter (TMC), an 8-bit modulo register (TMM), a comparator that compares the value of the timer with the value of the modulo register, and a selector that selects the operation clock of the 8-bit timer.

To start/stop the 8-bit timer, and to reset the 8-bit counter, TMEN (address 33H, bit 3) and TMRES (address 33H, bit 2) of the register file are used. To select the operation clock of the 8-bit timer, use TMCK1 (address 33H, bit 1) and TMCK0 (address 33H, bit 0) of the register file.

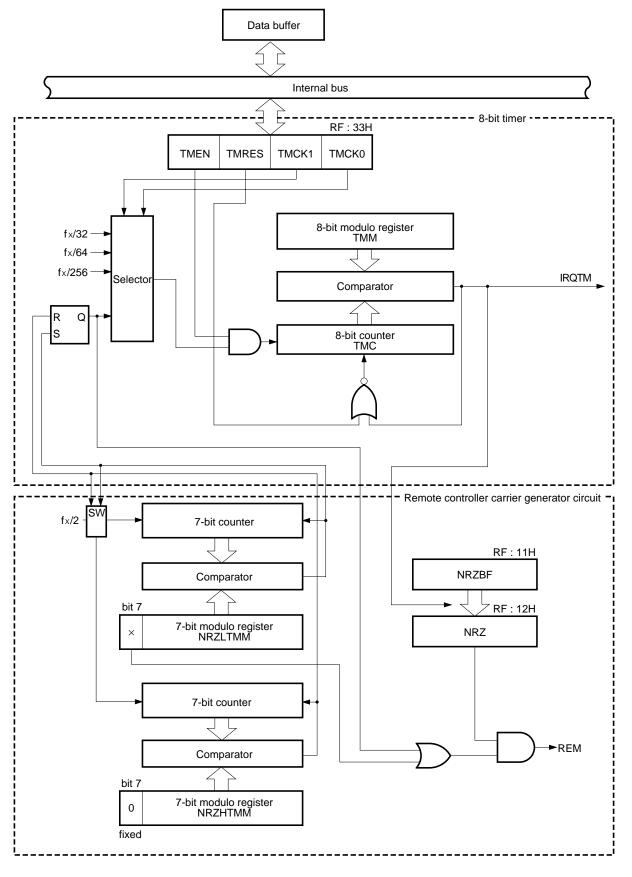
The value of the 8-bit counter is read by using the GET instruction through DBF (data buffer). No value can be set to the 8-bit counter. A value is set to the modulo register by using the PUT instruction through DBF. The value of the modulo register cannot be read.

When the value of the counter coincides with that of the modulo register, an interrupt flag (IRQTM: address 3FH, bit 0) of the register file is set.

TMC

	7	6	5	4	3	2	1	0	Address	On reset	R/W
			8	3-bit c	ounte	r			Peripheral register: 05H	00H	R
ТІ	MM										
	7	6	5	4	3	2	1	0	Address	On reset	R/W
		I I	8-bit	modu	ilo rec	gister	 	1	Peripheral register: 06H	FFH	W

Caution: Do note clear TMM to 0 (IRQTM is not set).



### Fig. 5-1 Configuration of 8-bit Timer and Remote Controller Carrier Generator Circuit



TMM, TMC, NRZLTMM, and NRZHTMM are peripheral registers.

### 3 2 1 0 Address On reset R/W 8H <sup>\*1</sup> R/W\*2 TMEN TMRES TMCK1 TMCK0 RF : 33H TMCK1 TMCK0 8-Bit Timer Clock Source Selection Count clock: fx/32 0 0 (Measurement time range: 8 µs to 2.048 ms) Count clock: fx/64 0 1 (Measurement time range: $16 \,\mu s$ to $4.096 \,ms$ ) Count clock : fx/256 0 1 (Measurement time range: $64 \,\mu s$ to $16.384 \,ms$ ) Remote control carrier generation circuit output 1 1 Value indicated by parentheses is for when (): $f_{SYS}$ (system clock) = $f_X = 4MHz$ TMRES 8-Bit Timer Reset Flag 0 Data read out is always "0" 1 Resets 8-bit counter and IRQTM TMEN 8-Bit Timer Count Enable Flag

0

1

Stops 8-bit timer count operation

Enable 8-bit timer count operation (falling edge)

### 5.2 Function of 8-bit Timer (with modulo function)

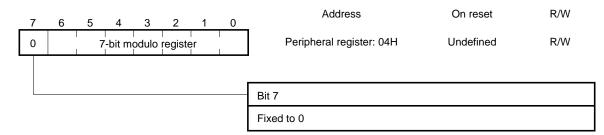
\*1: When the STOP mode is released, bit 3 must be set.

2: Bit 2 is a write-only bit.

### NRZLTMM

7	6	5	4	3	2	1	0		Address	On reset	R/W		
×		7	/ -bit m	odulo	registe	er		Peri	pheral register: 03H	Undefined	R/W		
								Bit 7	Bit 7 Output Control of REM Pin				
								0	When NRZ = 1, carrier output to REM pin				
								1	When NRZ = 1, high-le	vel output to REM pin			

### NRZHTMM



### 5.3 Carrier Generator Circuit for Remote Controller

 $\mu$ PD17215 is provided with a carrier generator circuit for the remote controller.

The remote controller carrier generator circuit consists of a 7-bit counter, NRZ high-level period setting modulo register (NRZHTMM), and NRZ low-level period setting modulo register (NRZLTMM). The high-level and low-level periods are set in the corresponding modulo registers through the DBF to determine the carrier duty factor and carrier frequency.

The system clock (f<sub>x</sub>) is divided by two and is input to the 7-bit counter. Therefore, when a 4-MHz oscillator is used, 2 MHz (0.5  $\mu$ s) is input to the counter as the clock; when a 32-kHz oscillator (fxT) is used, 16 kHz is input.

The NRZ high-level output period setting modulo register is called NRZHTMM, and the NRZ low-level period setting modulo register is called NRZLTMM. Data is written to these registers by the PUT instruction. The contents for these register are read by the GET instruction.

Bit 7 of NRZLTMM specifies whether the carrier or high level is output to the REM pin. To output the carrier, be sure to clear bit 7 to 0.

### 5.3.1 Remote controller signal output control

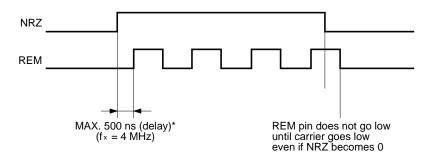
The REM pin, which outputs the carrier, is controlled by bits NRZ and NRZBF for the register file and timer 0. While the NRZ content is "1", the clock generated by the remote controller carrier generator circuit is output to the REM pin; while the NRZ content is "0", the REM pin outputs a low level. The NRZBF content is automatically transferred to NRZ by the interrupt signal generated by timer 0. If data is set in NRZBF in advance, the REM pin status changes in synchronization with the timer 0 counting operation.

If the interrupt signal is generated from timer 0 with the REM pin at the high level, NRZ being "1", and the carrier clock at the high level, the REM pin output is not in accordance with the updated content of NRZ, until the carrier clock goes low. This processing is useful for holding the high level pulse width from the output carrier constant (refer to the figure below).

When the content of NRZ is "0", the remote controller carrier generator circuit stops. However, if the clock for timer 0 is output from the remote controller carrier generator circuit, the clock continues to operate, even when the NRZ content becomes "0".

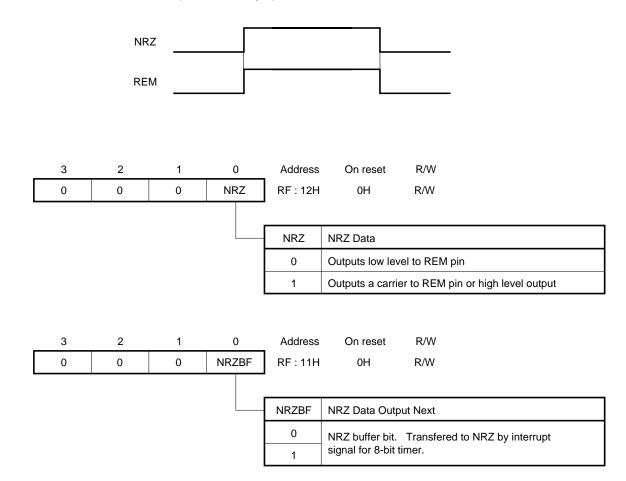
An actual example showing a remote controller signal output to the REM pin is presented below.

When bit 7 of NRZLTMM is 0 (carrier output)



\*: Value when (TMCK1, TMCK0)  $\neq$  (1, 1).

When (TMCK1, TMCK0) = (1, 1), the value differs depending on how NRZ is manipulated. If NRZ is set by an instruction, the width of the first high-level pulse may be shortened. If NRZ is set by data transferred from NRZBF, the high-level pulse is delayed by the low-level pulse of the carrier clock.



When bit 7 of NRZLTMM is 0 (carrier not output)

Setting carrier frequency and duty factor

Where the system clock frequency is fx and carrier frequency is fc:

 $\ell$  (division ratio) = fx/(2 × fc)

 $\boldsymbol{\ell}$  is divided into m:n and is set in the modulo registers as follows:

High-level period set value = { $\ell \times m/(m + n)$ } - 1 Low-level period set value = { $\ell \times n/(m + n)$ } - 1

Example: Where  $f_c = 38$  kHz, duty factor (high-level period) = 1/3, and  $f_x = 4$  MHz,

ℓ = 4 MHz/(2 x 38 kHz) = 52.6 m:n = 1:2

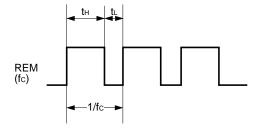
From the above, the value of the modulo register is:

High-level period = 17Low-level period = 34

Therefore, the carrier frequency is 37.74 kHz.

Set	value						
NRZHTMM	NRZLTMM	tн (µs)	t∟ (μs)	1/fc (µs)	fc (kHz)	Duty	
00H	00H	0.5	0.5	1.0	1000	1/2	
01H	02H	1.0	1.5	2.5	400	2/5	
04H	04H	2.5	2.5	5.0	200	1/2	
09H	09H	5.0	5.0	10.0	100	1/2	
0FH	10H	8.0	8.0	16.5	60.6	1/2	
0FH	21H	8.0	17.0	25.0	40.0	1/3	
11H	21H	9.0	17.0	26.0	38.5	1/3	
11H	22H	9.0	17.5	26.5	37.7	1/3	
19H	35H	13.0	27.0	40.0	25.0	1/3	
3FH	3FH	32.0	32.0	64.0	15.6	1/2	
7FH	7FH	64.0	64.0	120.0	7.8	1/2	

Table 5-1 Carrier Frequency List (fx = 4 MHz)



### 5.3.2 Countermeasures against noise during transmission (carrier output)

When a signal is transmitted from the transmitter of a remote controller, a peak current of 0.5 to 1 A may flow through the infrared LED. Since two batteries are usually used as the power source of the transmitter, several  $\Omega$  of equivalent resistance (r) exists in the power source as shown in Fig. 5-2. This resistance increases to 10 to 20  $\Omega$  if the supply voltage drops to 2 V. While the carrier is output from the REM pin (while the infrared LED lights), therefore, a high-frequency noise may be generated on the power lines due to the voltage fluctuation that may take place especially during switching.

To minimize the influence on the microcontroller of this high-frequency noise, take the following measures:

- <1> Separate the power lines of the microcontroller from the power lines of the infrared LED with the terminals of the batteries at the center. Use thick power lines and keep the wiring short.
- <2> Locate the oscillator as close as possible to the microcontroller and shield it with GND lines (as indicated by the shaded portion in the figure below).
- <3> Locate the capacitor for stabilization of the power supply closely to the power lines of the microcontroller. Also, use a capacitor to eliminate high-frequency noise.
- <4> To prevent data from changing, do not execute an interrupt that requires read/write processing and stack, such as key scan interrupt, and the CALL/RET instruction, while the carrier is output.
- <5> To improve the reliability in case of program hang-up, use the watchdog timer (connect the WDOUT and RESET pins).

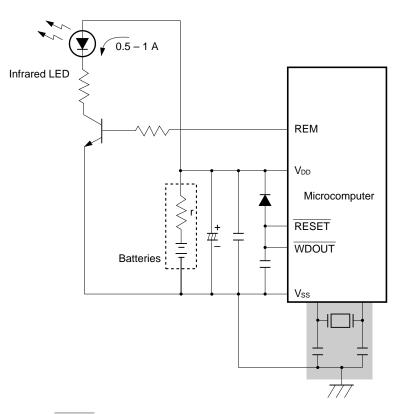


Fig. 5-2 Example of Countermeasures against Noise

- **Remarks 1:** The INT and RESET pins are multiplexed with test pins (refer to **1.4 NOTES ON USING OF INT AND RESET PINS**).
  - 2: In this figure, the RESET pin is connected to a pull-up resistor by mask option.

# 6. BASIC INTERVAL TIMER/WATCHDOG TIMER

The basic interval timer has a function to generate the interval timer interrupt signal and watchdog timer reset signal.

## 6.1 Source Clock for Basic Interval Timer

The system clock ( $f_x$ ) is divided, to generate the source clock for the basic interval timer. The input clock frequency for the basic interval timer is  $f_x/2^7$ . When the CPU is set in the STOP mode, the basic interval timer also stops.

### 6.2 Controlling Basic Interval Timer

The basic interval timer is controlled by the bits on the register file. That is, the basic interval timer is reset by BTMRES. The frequency for the interrupt signal, output by the basic interval timer, is selected by BTMMD, and the watchdog timer is reset by WDTRES.

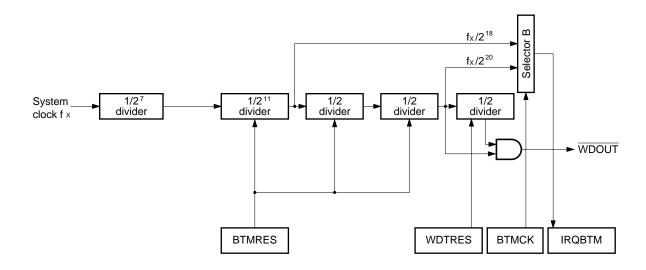


Fig. 6-1 Basic Interval Timer Configuration

3	:	2	1		0	Address	On reset	R/W
WDTRE	S BTN	ЛСК	BTMR	ES	0	RF : 03H	0H	R/W*
						BTMRES	Basic Interval	Timer Reset
						0	Data read out	is always "0"
						1	Writing "1" res	sets basic interval timer
						BTMCK	Basic Interval	Timer Mode Selection
						0	Generates inte	errupt signal IRQBTM every f x /2 <sup>20</sup>
						1	Generates inte	errupt signal IRQBTM every f x /2 <sup>18</sup>
						WDTRES	Watchdog Tim	ner Reset
						0	Data read out	is always "0"
						1	Writing "1" res	sets watchdog timer (fx/2 <sup>21</sup> counter)

\*: Bits 1 and 3 are write-only bits.

#### 6.3 Operation Timing for Watchdog Timer

The basic interval timer can be used as a watchdog timer.

Unless the watchdog timer is reset within a fixed time\*, it judges that "the program has hung up", and the  $\mu$ PD17215 is reset. It is therefore necessary to reset through programming the watchdog timer with in a fixed time.

The watchdog timer can be reset by setting WDTRES to 1.

\*: Fixed time: approx. 340 ms (at 4 MHz)

- Coutions 1: The watchdog timer cannot be reset in the shaded range in Fig. 6-2. Therefore, set WDTRES before both the  $f_x/2^{21}$  and  $f_x/2^{20}$  signals go high.
  - 2: Refer to 9. RESET for the WDOUT pin function.

f x /2<sup>18</sup> ٦Г ר ר רח ר η Γ 7 F fx /2<sup>19</sup> f x /2<sup>20</sup> f x /2<sup>21</sup> INTBTM (f x/2<sup>20</sup>) INTBTM (f x/2<sup>18</sup>) ▲ ▲ ▲ . ٨ ٨ ٨ 4 4 ٨ WDOUT WDOUT output goes low Watchdog timer if WDTRES is not set reset signal П WDTRES Setting WDTRES at this timing is invalid

Fig. 6-2 Watchdog Timer Operation Timing

# 7. INTERRUPT FUNCTIONS

#### 7.1 Interrupt Sources

 $\mu$ PD17217 is provided with three interrupt sources.

When an interrupt has been accepted, the program execution automatically branches to a predetermined address, which is called a vector address. A vector address is assigned to each interrupt source, as shown in Table 7-1.

Priority	Interrupt Source	Ext/Int	Vector Address
1	8-bit timer	Internal	0003H
2	INT pin rising and falling edges	External	0002H
3	Basic interval timer	Internal	0001H

#### Table 7-1 Vector Address

When more than one interrupt request is issued at the same time, the interrupts are accepted in sequence, starting from the one with the highest priority.

Whether an interrupt is enabled or disabled is specified by the EI or DI instruction. The basic condition under which an interrupt is accepted is that the interrupt is enabled by the EI instruction. While the DI instruction is executed, or while an interrupt is accepted, the interrupt is disabled.

To enable accepting an interrupt after the interrupt has been processed, the EI instruction must be executed before the RETI instruction. Accepting the interrupt is enabled by the EI instruction after the instruction next to the EI instruction has been executed. Therefore, no interrupt can be accepted between the EI and RETI instructions.

Caution: In interrupt processing, only the BCD, CMP, CY, Z, IXE flags are automatically saved to the stack by the hardware, to a maximum of three levels. Also, within the interrupt processing contents, when peripheral hardware (timer, A/D converter, etc.) is accessed, the DBF and WR contents are not saved by the hardware. Accordingly, it is recommended that at the beginning of interrupt processing DBF and WR be saved by software to RAM, and immediately before finishing interrupt processing the saved contents be returned to thier original location.

## 7.2 Hardware of Interrupt Control Circuit

This section describes the flags of the interrupt control circuit.

(1) Interrupt request flag and interrupt enable flag

The interrupt request flag (IRQxxx) is set to 1 when an interrupt request is generated, and is automatically cleared to 0 when the interrupt processing is excuted.

An interrupt enable flag (IPxxx) is provided to each interrupt request flag. When the IPxxx flag is 1, the interrupt is enabled; when it is 0, the interrupt is disabled.

(2) EI/DI instruction

Whether an accepted interrupt is executed or not is specified by the EI or DI instruction.

When the EI instruction is executed, INTE (interrupt enable flag), which enables the interrupt, is set to 1. The INTE flag is not registered on the register file. Consequently, the status of this flag cannot be checked by an instruction.

The DI flag clears the INTE flag to 0 to disable all the interrupts.

The INTE flag is also cleared to 0 at reset, disabling all the interrupts.

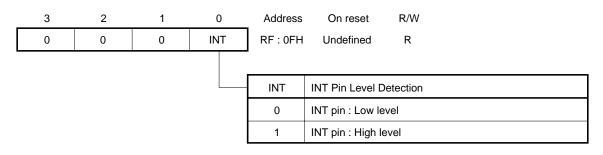
### Table 7-2 Interrupt Request Flags and Interrupt Enable Flag

Interrupt Request Flag	Signal Setting Interrupt Request Flag	Interrupt Enable Flag
IRQTM	Reset by 8-bit timer.	IPTM
IRQ	Set when edge of INT pin input signal is detected	IP
IRQBTM	Reset by basic interval timer.	IPBTM

## 7.2.1 INT

This flag reads the INT pin status.

When a high level is input to the INT pin, this flag is set to "1"; when a low level is input, the flag is reset to "0".



#### 7.2.2 IEG

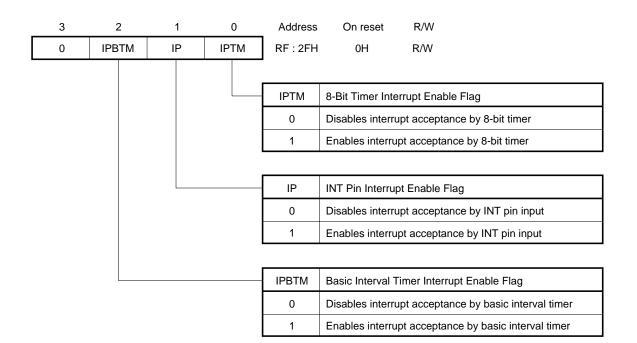
This pin selects the interrupt edge to be detected on the INT pin.

When this flag is "0", the interrupt is detected at the rising edge; when it is "1", the interrupt is detected at the falling edge.

 3	2	1	0	Address	On reset	R/W
0	0	0	IEG	RF : 1FH	0H	R/W
				IEG	INT Pin Interrup	ot Detection Edge Selection
				0	Rising edge of	INT pin
				1	Falling edge of	INT pin

## 7.2.3 Interrupt enable flag

This flag enables each interrupt source. When this flag is "1", the corresponding interrupt is enabled; when it is "0", the interrupt is disabled.

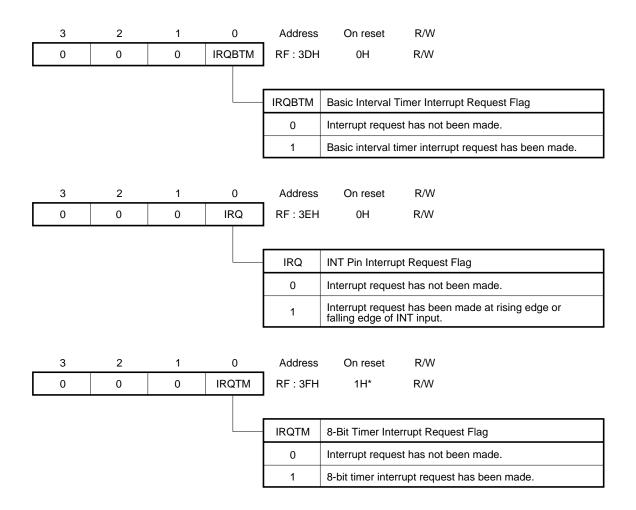


## 7.2.4 IRQ

This is an interrupt request flag that indicates the interrupt request status.

When an interrupt request is generated, this flag is set to "1". When the interrupt has been accepted, the interrupt request flag is reset to "0".

The interrupt request flag can be read or written by the program. Therefore, when it is set to "1", an interrupt can be generated by the software. By writing "0" to the flag, the interrupt pending status can be canceled.



\*: 1H is also set after releasing STOP mode.

#### 7.3 Interrupt Sequence

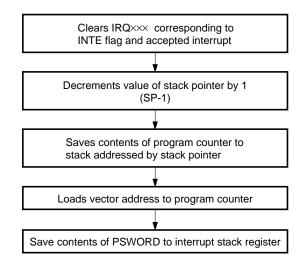
If IRQxxx flag is set to "1" when IPxxx flag is "1", interrupt processing is started after the instruction cycle of the instruction executed when IRQxxx flag was set has ended. Since the MOVT instruction, EI instruction, and the instruction which matches the condition to skip use two instruction cycles, the interrupt enabled while this instruction is executed is processed after the second instruction cycle is over.

If IPxxx flag is "0", the interrupt processing is not performed even if IRQxxx flag is set, until IPxx flag is set.

If two or more interrupts are enabled simultaneously, the interrupts are processed starting from the one with the highest priority. The interrupt with the lower priority is kept pending until the processing of the interrupt with the higher priority is finished.

#### 7.3.1 Operations when interrupt is accepted

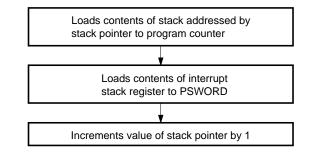
When an interrupt has been accepted, the CPU performs processing in the following sequence:



One instruction cycle is required to perform the above processing.

#### 7.3.2 Returning from interrupt processing routine

To return from an interrupt processing routine, use the RETI instruction. Then the following processing is executed within an instruction cycle.



To enable an interrupt after the processing of an interrupt has been finished, the El instruction must be executed immediately before the RETI instruction.

Accepting the interrupt is enabled by the El instruction after the instruction next to the El instruction has been executed. Therefore, the interrupt is not accepted between the El and RETI instructions.

## 8. STANDBY FUNCTIONS

 $\mu$ PD17215 is provided with HALT and STOP modes as standby functions. By using the standby function, current dissipation can be reduced.

In the HALT mode, the program is not executed, but the system clock  $f_x$  is not stopped. This mode is main-tained, until the HALT mode release condition is satisfied.

In the STOP mode, the system clock is stopped and program execution is stopped. This mode is maintained, until the STOP mode release condition is satisfied.

The HALT mode is set, when the HALT instruction has been executed. The STOP mode is set, when the STOP instruction has been executed.

#### 8.1 HALT Mode

In this mode, program execution is temporarily stopped, with the main clock continuing oscillating, to reduce current dissipation. Use the HALT instruction to set the HALT mode.

The HALT mode releasing condition can be specified by the operand for the HALT instruction, as shown in Table 8-1. After the HALT mode has been released, the operation is performed as shown in Table 8-1 and Figure 8-2.

# Caution: Do not execute an instruction that clears the interrupt request flag (IRQxxx) for which the interrupt enable flag (IPxxx) is set immediately before the HALT 8H instruction; otherwise, the HALT mode may not be set.

	<b>U</b>
Operand Value	Releasing Conditions
0010B (02H)	When interrupt request (IRQTM) occurs for 8-bit timer
1000B (08H)	<1> When interrupt request (IRQTM, IRQWTM, or IRQ), whose interrupt enable flag (IPTM, IPBTM, or IP) is set, occurs <2> When any of P0A <sub>0</sub> -P0A <sub>3</sub> and P0B <sub>0</sub> -P0B <sub>3</sub> pins goes low

#### Table 8-1 HALT Mode Releasing Conditions

#### Table 8-2 Operations After HALT Mode Release (1/2)

#### (a) HALT 08H

Other Than Above

Inhibited

HALT Mode Released by:	Interrupt Status	Interrupt Enable Flag	Operations after HALT Mode Release
Low-Level Input of P0A <sub>0</sub> -P0A <sub>3</sub> , P0B <sub>0</sub> -P0B <sub>3</sub>	Don't care	Don't care	Instruction next to HALT is executed
	DI	Disabled	Standby mode is not released
When Release Condition Is Satisfied by Interrupt	Ы	Enabled	Instruction next to HALT is executed
Satisfied by Interrupt	EI	Disabled	Standby mode is not released
		Enabled	Branches to interrupt vector address

#### Table 8-2 Operations After HALT Mode Release (2/2)

#### (b) HALT 02H

HALT Mode Released by:	Interrupt Status Interrupt Enable Flag		Operations after HALT Mode Release
	DI	Disabled	Instructions are executed from the
8-Bit Timer	Ы	Enabled	instruction next to the HALT
o-bit timer		Disabled	instruction.
	EI	Enabled	Branches to interrupt vector address

#### 8.2 HALT Instruction Execution Conditions

The HALT instruction can be executed, only under special conditions, as shown in Table 8-3, to prevent the program from hangup.

If the conditions in Table 8-3 are not satisfied, the HALT instruction is treated as an NOP instruction.

#### Table 8-3 HALT Instruction Execution Conditions

Operand Value	Execution Conditions
0010B (02H)	When all interrupt request flags (IRQTM) of 8-bit timer are reset
1000B (08H)	<ul> <li>&lt;1&gt; When interrupt request flag is reset, corresponding to interrupt whose interrupt enable flag (IPTM, IPBTM, or IP) is set</li> <li>&lt;2&gt; When high level is input to all P0A<sub>0</sub>-P0A<sub>3</sub> and P0B<sub>0</sub>-P0B<sub>3</sub> pins</li> </ul>
Other Than Above	Inhibited

#### 8.3 STOP Mode

In the STOP mode, the system clock (fx) oscillation is stopped and the program execution is stopped to minimize current dissipation.

To set the STOP mode, use the STOP instruction.

The STOP mode releasing condition can be specified by the STOP instruction operand, as shown in Table 8-4. After the STOP mode has released, the operation is performed as follows:

- <1> Resets IRQTM.
- <2> Starts the basic interval timer and watchdog timer (does not reset).
- <3> Resets and starts the 8-bit timer.
- <4> Executes the instruction next to [STOP 8H] when the current value of the 8-bit counter coincides with the value of the modulo register (IRQTM is set).

The  $\mu$ PD17215 oscillator circuit is stopped, when the STOP instruction has been executed (i.e., in the STOP mode). Oscillation is not resumed, until the STOP mode is released. After the STOP mode has been released, the HALT mode is set. Set the time required to release the HALT mode by using the timer with modulo function.

The time that elapses, after the STOP mode has been released by occurrence of an interrupt, until an operation mode is set, is shown in the following table.

8-Bit Modulo Register Set Value	Time Required to Set Operation Mode after STOP Mode Release	
(TMM)	At 4 MHz	
40H	4.160 ms (64 $\mu$ s $ imes$ 65)	
FFH	16.384 ms (64 $\mu$ s $ imes$ 256)	

Remark: Set the 8-bit modulo timer before executing STOP instruction.

Caution: Do not execute an instruction that clears the interrupt request flag (IRQxxx) for which the interrupt enable flag (IPxxx) is set immediately before the STOP 8H instruction; otherwise, the STOP mode may not be set.

Operand Value	Releasing Conditions
1000B (08H)	When any of P0A₀-P0A₃ and P0B₀-P0B₃ pins goes low
Others	Inhibited

#### Table 8-4 STOP Mode Releasing Conditions

#### 8.4 STOP Instruction Execution Conditions

The STOP instruction can be executed, only under special conditions, as shown in Table 8-5, to prevent the program from hangup.

If the conditions in Table 8-5 are not satisfied, the STOP instruction is treated as an NOP instruction.

Table 8-5 STOP I	Instruction	Execution	Conditions
------------------	-------------	-----------	------------

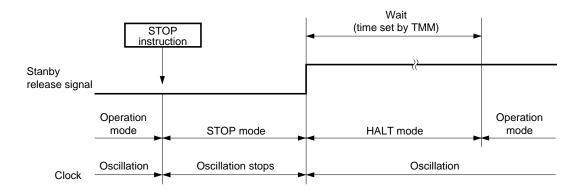
Operand Value	Execution Conditions
1000B (08H)	High level input for all P0A₀-P0A₃ and P0B₀-P0B₃ pins
Others	Inhibited

#### 8.5 Releasing Standby Mode

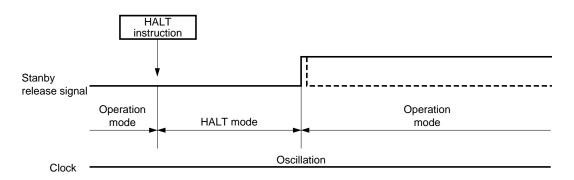
Operations for releasing the STOP and HALT modes will be as shown in Fig. 8-1.

#### Fig. 8-1 Operations After Standby Mode Release

(a) Releasing STOP mode by interrupt



#### (b) Releasing HALT mode by interrupt



**Remark:** The dotted line indicates the operation to be performed when the interrupt request, releasing the standby mode, has been accepted.

# 9. RESET

## 9.1 Reset by Reset Signal Input

When a low-level signal more than 50  $\mu$ s is input to the RESET pin,  $\mu$ PD17215 is reset.

When the system is reset, the oscillator circuit remains in the HALT mode and then enters an operation mode, like when the STOP mode has been released. The wait time, after the reset signal has been removed, is 16.384 ms ( $f_x = 4$  MHz).

On power application, input the reset signal at least once because the internal circuitry operations are not stable. When  $\mu$ PD17215 is reset, the following initialization takes place:

- (1) Program counter is reset to 0.
- (2) Flags in the register file are initialized to their default values (for the default values, refer to Fig. 11-1 Register Files).
- (3) The default value (0320H) is written to the data buffer (DBF).
- (4) The hardware peripherals are initialized.
- (5) The system clock (f<sub>x</sub>) stops oscillation.

When the RESET pin is made high, the system clock starts oscillating, and the program execution starts from address 0 about 16 ms (at 4 MHz) later.

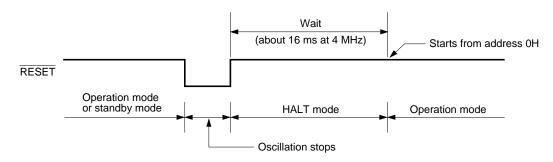


Fig. 9-1 Reset Operation by RESET Input

## 9.2 Reset by Watchdog Timer (Connect RESET and WDOUT pins)

When the watchdog timer operates during program execution, a low level is output to the WDOUT pin, and the program counter is reset to 0.

If the watchdog timer is not reset for a fixed period of time, the program can be restarted from address 0H.

Program so that the watchdog timer is reset at intervals of within 340 ms (at fx = 4 MHz) (set the WDTRES flag).

#### 9.3 Reset by Stack Pointer (Connect RESET and WDOUT pins)

When the value of the stack pointer reaches 6H or 7H during program execution, a low level is output to the WDOUT pin, and the program counter is reset to 0.

If the nesting level of the interrupt or subroutine call exceeds 5 (stack over flow), or if the return instruction is executed without correspondence between CALL and return (RET) instructions established, then regardless of a stack level of 0 (stack underflow), the program can be restarted from address 0H.

	Hardware	RESET Input During Standby Mode	RESET Input During Operation		
Program Counter (PC)		0000H	0000H		
Port	Input/output	Input	Input		
	Output latch	0	0		
Data Memory (RAM)	General-purpose data memory (Except DBF, port register)	Retains previous status	Undefined		
	DBF	0320H	0320H		
	System register (SYSREG)	0	0		
	WR	Retains previous status	Undefined		
Control Register		Refer to Fig. 11-1 Register Files			
8-bit Timer	Counter (TMC)	00H	00H		
	Modulo register (TMM)	FFH	FFH		
Remote Controller Carrier Generator	NRZ high level period setting modulo register (NRZHTMM)	Retains previous status	Undefined		
	NRZ low level period setting modulo register (NRZLTMM)				
Basic Interval Timer/Watchdo	g Timer Counter	00H	00H		

#### Table 9-1 Status of Each Hardware After Reset

# 10. LOW-VOLTAGE DETECTOR CIRCUIT (CONNECT RESET AND WDOUT PINS)

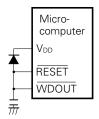
The low-voltage detector circuit outputs a low level from the WDOUT pin for initialization (reset) to prevent program hangup that may take place when the batteries are replaced, if the circuit detects a low voltage.

A drop in the supply voltage is detected if the status of  $T_A = -10$  to  $+85^{\circ}$ C,  $V_{DD} = 0.8$  to 2.2 V lasts for 1 ms or longer. Note, however, that 1 ms is the guaranteed value and that the microcontroller may be reset even if the above low-voltage condition lasts for less than 1 ms.

Although the voltage at which the the reset function is effected ranges from 0.8 to 2.2 V, the program counter is prevented from hang-up even if the supply voltage drops until the reset function is effected, if the instruction execution time is from 8 to 32  $\mu$ s. Note that some oscillators stop oscillating before the reset function is effected.

The low-voltage detector circuit can be set arbitrarily by the mask option.

Caution: Connect a diode and a capacitor to the RESET pin as shown below to stabilize the operation.



**Remark:** In this figure, the **RESET** pin is connected to a pull-up resistor by the mask option.

## 11. ASSEMBLER RESERVED WORDS

#### 11.1 Mask Option Directives

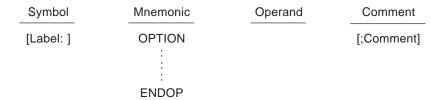
When developing the  $\mu$  PD17215 program, mask options must be specified by using mask option directives in the program.

The RESET pin for  $\mu$ PD17215 requires a mask option to be specified.

#### 11.1.1 OPTION and ENDOP directives

That portion of the program enclosed by the OPTION and ENDOP directives is called a mask option definition block. This block is described in the following format:

Description:



#### 11.1.2 Mask option definition directives

Table 19-1 lists the directives that can be used in the mask option definition block. Here is an example of mask option definition:

Description format:

Symbol field	Mnemonic field	Operand field	Comment field
	OPTION		
	OPTRES	PULLUP	; RESET pin has pull-up resistors.
	OPTPOC	USEPOC	; Internal low-voltage detector circuit
	ENDOP		

Name	Directive	Operands	1st Operand	2nd Operand	3rd Operand	4th Operand
			Mask option of RESET			
RESET	OPTRES	1	PULLUP (w/pull-up resistor) OPEN (w/o pull-up resistor)			
POC	OPTPOC	1	USEPOC (low-voltage detector circuit provided)			
	UF IFUC	1	NOUSEPOC (low-voltage detector circuit not provided)			

#### Table 11-1 Mask Option Definition Directives

#### 11.2 Reserved Symbols

The symbols defined by the  $\mu$ PD17215 device file are listed in Table 11-2.

The defined symbols are the following register file names, port names, and peripheral hardware names.

#### 11.2.1 Register file

The names of the symbols assigned to the register file are defined. These registers are accessed by the PEEK and POKE instructions through the window register (WR). Fig. 11-1 shows the register file.

#### 11.2.2 Registers and ports on data memory

The names of the registers assigned at addresses 00H through 7FH on the data memory and the names of ports assigned to address 70H and those that follow, and system register names are defined. Fig. 11-2 shows the data memory configuration.

#### 11.2.3 Peripheral hardware

The names of peripheral hardware accessed by the GET and PUT instructions are defined. Table 11-3 shows the peripheral hardware.

Symbol Name	Attribute	Value	R/W	Description
DBF3	MEM	0.0CH	R/W	Bits 15-12 of data buffer
DBF2	MEM	0.0DH	R/W	Bits 11-8 of data buffer
DBF1	MEM	0.0EH	R/W	Bits 7-4 of data buffer
DBF0	MEM	0.0FH	R/W	Bits 3-0 of data buffer
AR3	MEM	0.74H	R	Bits 15-12 of address register
AR2	MEM	0.75H	R/W	Bits 11-8 of address register
AR1	MEM	0.76H	R/W	Bits 7-4 of address register
AR0	MEM	0.77H	R/W	Bits 3-0 of address register
WR	MEM	0.78H	R/W	Window register
BANK	MEM	0.79H	R	Bank register
IXH	MEM	0.7AH	R	Bits 11-8 of index register
MPH	MEM	0.7AH	R	Bits 7-4 of memory pointer
MPE	FLG	0.7AH.3	R/W	Memory pointer enable flag
IXM	MEM	0.7BH	R/W	Bits 7-4 of index register
MPL	MEM	0.7BH	R/W	Bits 3-0 of memory pointer
IXL	MEM	0.7CH	R/W	Bits 3-0 of index register
RPH	MEM	0.7DH	R	Bits 7-4 of register pointer
RPL	MEM	0.7EH	R/W	Bits 3-0 of register pointer
PSW	MEM	0.7FH	R/W	Program status word
BCD	FLG	0.7EH.0	R/W	BCD flag
CMP	FLG	0.7FH.3	R/W	Compare flag
CY	FLG	0.7FH.2	R/W	Carry flag
Z	FLG	0.7FH.1	R/W	Zero flag
IXE	FLG	0.7FH.0	R/W	Index register enable flag
P0A0	FLG	0.70H.0	R/W	Bit 0 of port 0A
P0A1	FLG	0.70H.1	R/W	Bit 1 of port 0A
P0A2	FLG	0.70H.2	R/W	Bit 2 of port 0A
P0A3	FLG	0.70H.3	R/W	Bit 3 of port 0A
P0B0	FLG	0.71H.0	R/W	Bit 0 of port 0B
P0B1	FLG	0.71H.1	R/W	Bit 1 of port 0B
P0B2	FLG	0.71H.2	R/W	Bit 2 of port 0B
P0B3	FLG	0.71H.3	R/W	Bit 3 of port 0B
P0C0	FLG	0.72H.0	R/W	Bit 0 of port 0C
P0C1	FLG	0.72H.1	R/W	Bit 1 of port 0C
P0C2	FLG	0.72H.2	R/W	Bit 2 of port 0C
P0C3	FLG	0.72H.3	R/W	Bit 3 of port 0C
P0D0	FLG	0.73H.0	R/W	Bit 0 of port 0D
P0D1	FLG	0.73H.1	R/W	Bit 1 of port 0D
P0D2	FLG	0.73H.2	R/W	Bit 2 of port 0D
P0D3	FLG	0.73H.3	R/W	Bit 3 of port 0D

# Table 11-2 Reserved Symbols (1/2)

Symbol Name	Attribute	Value	R/W	Description
P0E0	FLG	0.6FH.0	R/W	Bit 0, port 0E
P0E1	FLG	0.6FH.1	R/W	Bit 1, port 0E
P0E2	FLG	0.6FH.2	R/W	Bit 2, port 0E
P0E3	FLG	0.6FH.3	R/W	Bit 3, port 0E
SP	MEM	0.81H	R/W	Stack pointer
SYSCK	FLG	0.82H.0	R/W	Selects system clock
WDTRES	FLG	0.83H.3	R/W	Resets watchdog timer
BTMCK	FLG	0.83H.2	R/W	Selects basic interval timer mode
BTMRES	FLG	0.83H.1	R/W	Resets basic interval timer mode
INT	FLG	0.8FH.0	R	INT pin status
NRZBF	FLG	0.91H.0	R/W	NRZ buffer data
NRZ	FLG	0.92H.0	R/W	NRZ data
P0EBPU0	FLG	0.97H.0	R/W	Pull-up resistor setting flag for P0E <sub>0</sub>
P0EBPU1	FLG	0.97H.1	R/W	Pull-up resistor setting flag for P0E1
P0EBPU2	FLG	0.97H.2	R/W	Pull-up resistor setting flag for P0E <sub>2</sub>
P0EBPU3	FLG	0.97H.3	R/W	Pull-up resistor setting flag for P0E₃
IEG	FLG	0.9FH.0	R/W	Selects interrupt edge for INT pin
P0EBIO0	FLG	0.0A7H.0	R/W	I/O setting flag, P0E₀
P0EBIO1	FLG	0.0A7H.1	R/W	I/O setting flag, P0E1
P0EBIO2	FLG	0.0A7H.2	R/W	I/O setting flag, P0E <sub>2</sub>
P0EBIO3	FLG	0.0A7H.3	R/W	I/O setting flag, P0E₃
IPBTM	FLG	0.0AFH.2	R/W	Interrupt enable flag of basic interval timer
IP	FLG	0.0AFH.1	R/W	INT interrupt enable flag
IPTM	FLG	0.0AFH.0	R/W	8-bit timer interrupt enable flag
TMEN	FLG	0.0B3H.3	R/W	8-bit timer count enable flag
TMRES	FLG	0.0B3H.2	R/W	8-bit timer reset flag
TMCK1	FLG	0.0B3H.1	R/W	Selects clock source for 8-bit timer
ТМСК0	FLG	0.0B3H.0	R/W	Selects clock source for 8-bit timer
IRQBTM	FLG	0.0BDH.0	R/W	Basic interval timer interrupt request flag
IRQ	FLG	0.0BEH.0	R/W	INT interrupt request flag
IRQTM	FLG	0.0BFH.0	R/W	8-bit timer interrupt request flag
ТМС	DAT	05H	R	8-bit counter
ТММ	DAT	06H	W	8-bit modulo register
NRZLTMM	DAT	03H	R/W	NRZ low level period setting modulo register
NRZHTMM	DAT	04H	R/W	NRZ high level period setting modulo register
AR	DAT	40H	R/W	Address register

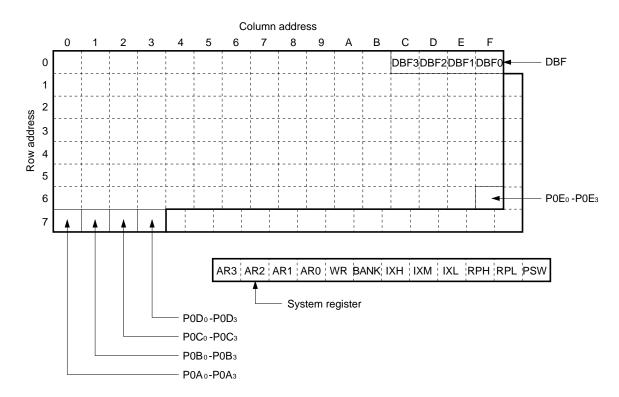
# Table 11-2 Reserved Symbols (2/2)

	Column Address	0	1		2		3		4	5	6	7	
Rov Add	v Iress	*	-	*		*			*	*	*	*	
	Bit 3			0	0	0	WDTRES	0					
0	Bit 2		SP	1	0	0	BTMCK	0					
	Bit 1		] 55	0	0	0	BTMRES	0					
	Bit 0		]	1	SYSCK	0	0	0					
	Bit 3		0	0	0	0						P0EBPU3	0
1	Bit 2		0	0	0	0						P0EBPU2	0
'	Bit 1		0	0	0	0						P0EBPU1	0
	Bit 0		NRZBF	0	NRZ	0						P0EBPU0	0
	Bit 3											P0EBIO3	0
2	Bit 2											P0EBIO2	0
	Bit 1											P0EBIO1	0
	Bit 0											P0EBIO0	0
	Bit 3						TMEN	1					
3	Bit 2						TMRES	0					
3	Bit 1						TMCK1	0					
	Bit 0						TMCK0	0					

Fig. 11-1 Register Files (1/2)

\*: On reset





$\left[ \right]$	Column Address	8	9	A	В	С	D	E		F	
Rov Add	v Iress	*	*	*	*	*	*	,		*	
	Bit 3									0	0
0	Bit 2									0	0
	Bit 1									0	0
	Bit 0									INT	Ρ
	Bit 3									0	0
1	Bit 2									0	0
	Bit 1									0	0
	Bit 0									IEG	0
	Bit 3									0	0
	Bit 2									IPBTM	0
2	Bit 1									IP	0
	Bit 0									IPTM	0
	Bit 3						0	0 0	0	0	0
	Bit 2						0	0 0	0	0	0
3	Bit 1						0	0 0	0	0	0
	Bit 0						IRQBTM	0 IRQ	0	IRQTM	1

# Fig. 11-1 Register Files (2/2)

## \*: On reset

P: When INT pin is high level, 1 or when INT pin is low level, 0.

Name	Address	Valid Bit	Description			
TMC	05H	8	8-bit timer count register			
ТММ	06H	8	8-bit timer modulo register			
NRZLTMM	03H	8	Low level period setting modulo register for remote controller carrier generation			
NRZHTMM	04H	8	High level period setting modulo register for remote controller carrier generation			
AR	40H	16	Address register			

### Table 11-3 Peripheral Hardwre

# **12. INSTRUCTION SET**

## 12.1 Instruction Set Outline

	b15				
b14-b11			0		1
BIN.	HEX.				
0000	0	ADD	r, m	ADD	m, #n4
0001	1	SUB	r, m	SUB	m, #n4
0010	2	ADDC	r, m	ADDC	m, #n4
0011	3	SUBC	r, m	SUBC	m, #n4
0100	4	AND	r, m	AND	m, #n4
0101	5	XOR	r, m	XOR	m, #n4
0110	6	OR	r, m	OR	m, #n4
		INC	AR		
		INC	IX		
		MOVT	DBF, @AR		
		BR	@AR		
		CALL	@AR		
		RET			
		RETSK			
		EI			
		DI			
0111	7	RETI			
		PUSH	AR		
		POP	AR		
		GET	DBF, p		
		PUT	p, DBF		
		PEEK	WR, rf		
		POKE	rf, WR		
		RORC	r		
		STOP	S		
		HALT	h		
		NOP			
1000	8	LD	r, m	ST	m, r
1001	9	SKE	m, #n4	SKGE	m, #n4
1010	А	MOV	@r, m	MOV	m, @r
1011	В	SKNE	m, #n4	SKLT	m, #n4
1100	С	BR	addr (Page 0)	CALL	addr
1101	D	BR	addr (Page 1)	MOV	m, #n4
1110	E	BR	addr (Page 2)	SKT	m, #n
1111	F	BR	addr (Page 3)	SKF	m, #n

# 12.2 Legend

AR	: Address register	
ASR	: Address stack register specified by stack pointer	stack pointer
addr	: Program memory address (lower 11 bits)	1 bits)
BANK	: Bank register	
CMP	: Compare register	
CY	: Carry flag	
DBF	: Data buffer	
h	: Halt releasing condition	
INTEF	: Interrupt enable flag	
INTR	: Register automatically saved to stack in case of interrup	ack in case of interrupt
INTSK	: Interrupt stack register	
IX	: Index register	
MP	: Data memory row address pointer	
MPE	: Memory pointer enable flag	
m	: Data memory address specified by mR, mc	mr, mc
МR	: Data memory row address (high)	
	· Data mamary column address (low)	
mc	: Data memory column address (low)	()
mc n	: Bit position (4 bits)	)
		)
n	: Bit position (4 bits)	
n n4	<ul><li>Bit position (4 bits)</li><li>Immediate data (4 bits)</li></ul>	
n n4 PAGE	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> </ul>	
n n4 PAGE PC	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> </ul>	
n n4 PAGE PC p	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> <li>Peripheral address</li> </ul>	
n n4 PAGE PC p pH	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> <li>Peripheral address</li> <li>Peripheral address (higher 3 bits)</li> </ul>	
n n4 PAGE PC p pH pL	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> <li>Peripheral address</li> <li>Peripheral address (higher 3 bits)</li> <li>Peripheral address (lower 4 bits)</li> </ul>	
n n4 PAGE PC p pH pL r	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> <li>Peripheral address</li> <li>Peripheral address (higher 3 bits)</li> <li>Peripheral address (lower 4 bits)</li> <li>General register column address</li> </ul>	unter)
n n4 PAGE PC р рн р∟ r	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> <li>Peripheral address</li> <li>Peripheral address (higher 3 bits)</li> <li>Peripheral address (lower 4 bits)</li> <li>General register column address</li> <li>Register file address</li> </ul>	unter)
n n4 PAGE PC р рн рL r rf	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> <li>Peripheral address</li> <li>Peripheral address (higher 3 bits)</li> <li>Peripheral address (lower 4 bits)</li> <li>General register column address</li> <li>Register file address (higher 3 bits)</li> </ul>	unter)
n n4 PAGE PC p pH pL r rf rfR rfR	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> <li>Peripheral address</li> <li>Peripheral address (higher 3 bits)</li> <li>Peripheral address (lower 4 bits)</li> <li>General register column address</li> <li>Register file address (higher 3 bits)</li> <li>Register file address (lower 4 bits)</li> <li>Register file address (lower 4 bits)</li> </ul>	unter)
n n4 PAGE PC p pH pL r rf rfR rfR rfC SP	<ul> <li>Bit position (4 bits)</li> <li>Immediate data (4 bits)</li> <li>Page (bit 11 and 12 of program counter)</li> <li>Program counter</li> <li>Peripheral address</li> <li>Peripheral address (higher 3 bits)</li> <li>Peripheral address (lower 4 bits)</li> <li>General register column address</li> <li>Register file address</li> <li>Register file address (higher 3 bits)</li> <li>Register file address (lower 4 bits)</li> <li>Stack pointer</li> </ul>	unter)

# 12.3 List of Instruction Sets

					Instructi	on Code	
Group	Mnemonic	Operand	Operation	OP Code		Operand	
	455	r, m	$(r) \leftarrow (r) + (m)$	00000	МR	mc	r
	ADD -	m, #n4	(m) ← (m) + n4	10000	МR	mc	n4
A .1.111	4000	r, m	$(r) \leftarrow (r) + (m) + CY$	00010	МR	mc	r
Addition	ADDC -	m, #n4	$(m) \gets (m) + n4 + CY$	10010	МR	mc	n4
	INIO	AR	$AR \leftarrow AR + 1$	00111	000	1001	0000
	INC -	IX	$IX \leftarrow IX + 1$	00111	000	1000	0000
	0110	r, m	$(r) \leftarrow (r) - (m)$	00001	МR	mc	r
Subtrac-	SUB -	m, #n4	$(m) \leftarrow (m) - n4$	10001	МR	mc	n4
tion	CLIDO	r, m	$(r) \leftarrow (r) - (m) - CY$	00011	ΜR	mc	r
	SUBC -	m, #n4	Code         Operand           (r) $\leftarrow$ (r) + (m)         00000         ma         mc           (m) $\leftarrow$ (m) + n4         10000         ma         mc           (m) $\leftarrow$ (r) + (m) + CY         00010         ma         mc           (m) $\leftarrow$ (m) + n4 + CY         10010         ma         mc           AR $\leftarrow$ AR +1         00111         0000         1001           IX $\leftarrow$ IX +1         00111         0000         1000           (r) $\leftarrow$ (r) - (m)         00001         ma         mc           (m) $\leftarrow$ (m) - n4         10001         ma         mc           (m) $\leftarrow$ (m) - n4 - CY         10011         ma         mc           (m) $\leftarrow$ (m) - n4 - CY         10011         ma         mc           (m) $\leftarrow$ (m) - n4 - CY         10011         ma         mc           (m) $\leftarrow$ (m) A + CY         10010         ma         mc           (m) $\leftarrow$ (m) A + CY         10011         ma         mc           (m) $\leftarrow$ (m) A + CY         10011         ma         mc           (m) $\leftarrow$ (m) A + CY         10011         ma         mc           (m) $\leftarrow$ (m) A + CY         10010         ma         mc           (m) $\leftarrow$ (m) A + A         10100         ma </td <td>n4</td>	n4			
	0.5	r, m	$(r) \leftarrow (r) \lor (m)$	00110	МR	mc	r
	OR -	m, #n4	$(m) \leftarrow (m) \lor n4$	10110	МR	mc	n4
_ Logical	r, m $(r) \leftarrow (r) \land (m)$		00100	МR	mc	r	
Logical	AND -	m, #n4	$(m) \leftarrow (m) \land n4$	10100	МR	mc	n4
	VOD	r, m	$(r) \leftarrow (r) \ \forall \ (m)$	00101	МR	mc	r
	XOR	m, #n4	$(m) \leftarrow (m) \ \forall \ n4$	10101	МR	mc	n4
ludere	SKT	m, #n	$CMP \leftarrow 0$ , if (m) $\land$ n = n, then skip	11110	МR	mc	n
Judge	SKF	m, #n	$CMP \leftarrow 0$ , if (m) $\land$ n = 0, then skip	11111	МR	mc	n
	SKE	m, #n4	(m)-n4, skip if zero	01001	МR	mc	n4
Compore	SKNE	m, #n4	(m)-n4, skip if not zero	01011	МR	mc	n4
Compare	SKGE	m, #n4	(m)-n4, skip if not borrow	11001	МR	mc	n4
	SKLT	m, #n4	(m)-n4, skip if borrow	11011	МR	mc	n4
Rotate	RORC	r	$\blacktriangleright CY \rightarrow (r)_{b3} \rightarrow (r)_{b2} \rightarrow (r)_{b1} \rightarrow (r)_{b0}$	00111	000	0111	r
	LD	r, m	$(r) \leftarrow (m)$	01000	МR	mc	r
	ST	m, r	(m) ← (r)	11000	МR	mc	r
		@r, m		01010	МR	mc	r
Transfer	MOV	$ \begin{tabular}{lllllllllllllllllllllllllllllllllll$		11010	МR	mc	r
		m, #n4	(m) ← n4	11101	mr	mc	n4
	MOVT	DBF, @AR	$SP \leftarrow SP - 1$ , $ASR \leftarrow PC$ , $PC \leftarrow AR$ $DBF \leftarrow (PC)$ , $PC \leftarrow ASR$ , $SP \leftarrow SP + 1$	00111	000	0001	0000

						Instructi	on Code				
Group	Mnemonic	Operand		Operation	OP Code		Operand				
	PUSH	AR	$SP \gets SP -$	1, ASR $\leftarrow$ AR	00111	000	1101	0000			
	POP	AR	$AR \gets ASR,$	$SP \leftarrow SP + 1$	Code         Operand           00111         000         1101         00           00111         000         1100         00           00111         rfr         0011         rfr           00111         pH         1011         r           00111         pH         1010         r           00111         pH         1010         r           00111         pH         1010         r           001100         pAGE <-0	0000					
Trenefer	PEEK	WR, rf	$WR \gets (rf)$		00111	rf <sub>R</sub>	Operand         1101         1100         0011         0010         1011         1010         1010         1010         0         1010         1010         0         1010         0         1010         0         0         0         0         0         0         0         0         0         0         1         0         1         0         1         0         1         1         0         1         0         1         0         1         0         1         0         1         0         1         0         1         0         1         0         1         0         1         0	rfc			
Transfer	POKE	rf, WR	$(rf) \gets WR$		00111	OP Code         Operand           00111         000         1101         0000           00111         000         1100         0000           00111         rfr         0011         rfr           00111         rfr         0010         rfr           00111         pH         1011         pL           00111         pH         1010         pL           01100         o         addr         o           01101         o         addr         o           01101         o         o         o           01101         o         o         o           01100         addr         o         o           01101         o         o         o           01111         o         o         o           01111         o         o         o           00111         o         o         o           00111	rfc				
	GET	DBF, p	$(DBF) \leftarrow (p)$		00111		p∟				
	PUT	p, DBF	$(p) \leftarrow (DBF)$		00111	рн	1100       0         0011       0         1011       1         1010       0         addr       0         0100       0         0101       0         0101       0	p∟			
			μPD17215	PC₁₀₋₀ ← addr	01100						
			μPD17216	$PC_{100} \gets addr,  PAGE \gets 0$	01100						
	BR		μεστ/216	$PC_{100} \gets addr,  PAGE \gets 1$	01101						
				$PC_{100} \gets addr,  PAGE \gets 0$	01100						
Branch		addr	μPD17217	$PC_{100} \gets addr,  PAGE \gets 1$	01101	addr					
Branch	ВК	addr		$PC_{100} \gets addr,  PAGE \gets 2$	01110						
			μPD17218	$PC_{100} \leftarrow addr,  PAGE \leftarrow 0$	01100						
				$PC_{100} \gets addr,  PAGE \gets 1$	01101						
				μ	μΡΟ17218	$PC_{100} \gets addr,  PAGE \gets 2$	01110				
				$PC_{100} \gets addr,  PAGE \gets 3$	01111						
		@AR	$PC \gets AR$		00111	000	0100	0000			
	CALL	addr		1, ASR ← PC, dr, PAGE ← 0	11100		addr				
Sub-	CALL	@AR	$\begin{array}{l} SP \leftarrow SP - \\ PC \leftarrow AR \end{array}$	1, ASR ← PC,	00111	000	0101	0000			
routine	RET		$PC \gets ASR,$	$SP \gets SP \texttt{+1}$	00111	000	1110	0000			
	RETSK		$PC \gets ASR,$	$SP \leftarrow SP + 1$ and skip	00111	001	1110	0000			
	RETI		$PC \gets ASR,$	$INTR \leftarrow INTSK,  SP \leftarrow SP + 1$	00111	100	1110	0000			
Interrupt	EI		INTEF ← 1 00111		000	1111	0000				
			$INTEF \leftarrow 0$		00111	001	1111	0000			
	STOP	S	STOP		00111	010	1111	S			
Other	HALT	h	HALT		00111	011	1111	h			
	NOP		No operatio	n	00111	100	addr       0     0101       0     1110       1110     0       1110     0       1111     0       1111     0       1111     0       1111     0       1111     0       1111     0       1111     0	0000			

#### 12.4 Assembler (AS17K) Built-In Macro Instruction

Legend

- flag n: FLG type symbol
- < >: Contents in < > can be omitted

	Mnemonic	Operand	Operation	n
	SKTn	flag 1,flag n	if (flag 1) to (flag n) = all "1", then skip	$1 \le n \le 4$
	SKFn	flag 1,flag n	if (flag 1) to (flag n) = all "0", then skip	$1 \le n \le 4$
macro	SETn	flag 1,flag n	(flag 1) to (flag n) $\leftarrow$ 1	$1 \le n \le 4$
	CLRn	flag 1,flag n	(flag 1) to (flag n) $\leftarrow$ 0	$1 \le n \le 4$
Built-in	NOTn		if (flag n) = "0", then (flag n) $\leftarrow$ 1	1 ≤ n ≤ 4
Bui	NOTI	flag 1,flag n	if (flag n) = "1", then (flag n) $\leftarrow 0$	1 2 11 2 4
	INITFLG	<not> flag 1,</not>	if description = NOT flag n, then (flag n) $\leftarrow 0$	1 ≤ n ≤ 4
	INITEG	···< <not> flag n&gt;</not>	if description = flag n, then (flag n) $\leftarrow$ 1	1 ≥ 11 ≥ 4
	BANKn		$(BANK) \leftarrow n$	n = 0, 1

# **13. ELECTRICAL SPECIFICATIONS**

## Absolute Maximum Ratings (T<sub>A</sub> = $25^{\circ}$ C)

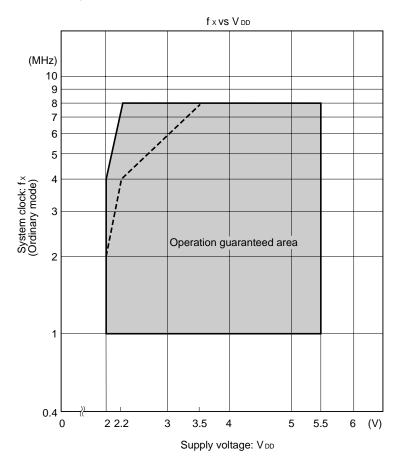
Item	Symbol	Conditio	ns	Ratings	Unit
Supply Voltage	Vdd			-0.3 to +7.0	V
Input Voltage	Vı			-0.3 to Vpp+0.3	V
Output Voltage	Vo			-0.3 to Vpp+0.3	V
			Peak value	-36.0	mA
	VDD-0.3 to +7.V1-0.3 to VDD+V0-0.3 to VDD+V0-0.3 to VDD+V0-0.3 to VDD+IOHREM pin1 pin (POE pin)Peak value1 pin (POE pin)Peak valueTotal of POE pinsPeak value1 pin (POC, POD, POE, REM or WDOUT pin)Peak value1 pin (POC, POD, WDOUT pin)Peak value1 pin (POE pinsPeak value1 pin (POC, POD, POE, REM or WDOUT pin)Peak value1 pin (POC, POD, WDOUT pin)Peak value1 pin (POE pinsEffective value1 pin (POC, POD, WDOUT pin)Peak value1 pin (POE, POD, WDOUT pin)Peak value1 pin (POE pinsEffective value1 pin (POE pinsPeak value1 pin (	-24.0	mA		
High-Level Output	Іон		Peak value	-7.5	mA
Current*		1 pin (P0E pin)	Effective value	-5.0	mA
			Peak value	-22.5	mA
		Total of PUE pins	Effective value	-15.0	mA
		1 pin (P0C, P0D, P0E,	Peak value	-0.3 to Vbb+0.3         -0.3 to Vbb+0.3         Peak value         -36.0         Effective value         -24.0         Peak value         -7.5         Effective value         -5.0         Peak value         -22.5         Effective value         -15.0         Peak value         -25.0         Peak value         -22.5         Effective value         -15.0         Peak value         25.0         Peak value         15.0         Peak value         22.5         Effective value         5.0         Peak value         22.5         Effective value         15.0         Peak value         30.0         Effective value         20.0         -40 to +85         -65 to +150	mA
		REM or WDOUT pin)	Effective value		mA
Low-Level Output		Total of P0C, P0D,	Peak value	22.5	mA
Current*		WDOUT pins	Effective value	-0.3 to Vbb+0.3       No         -0.3 to Vbb+0.3       No         -36.0       m         -24.0       m         -7.5       m         -5.0       m         -22.5       m         -15.0       m         22.5       m         15.0       m         30.0       m         -40 to +85       °         -65 to +150       °	mA
	lol		Peak value	30.0	mA
		Total of PUE pins	Effective value	20.0	mA
Operating Ambient Temperature	TA			-40 to +85	°C
Storage Temperature	Tstg			-65 to +150	°C
Power Dissipation	Pd	T <sub>A</sub> = 85 °C		180	mW

\*: Calculate effective value by this expression: [Effetive value] = [Peak value]  $\times \sqrt{\text{Duty}}$ 

Caution: Even if one of the parameters exceeds its absolute maximum rating even momentarily, the quality of the product may be degraded. The absolute maximum rating therefore specifies the upper or lower limit of the value at which the product can be used without physical damages. Be sure not to exceed or fall below this value when using the product.

Item	Symbol		Conditions	MIN.	TYP.	MAX.	Unit
	Vdd1	f <sub>x</sub> = 1 MHz	High-speed mode (Instruction execution time: 16 $\mu$ s)				
Supply Voltage     fx = 4 MHz       VDD3     High-speed mode	Ordinary mode (Instruction execution time: 8 $\mu$ s)	2.0	3.0	5.5	.,		
Supply Voltage	Vdd3	/DD3	High-speed mode (Instruction execution time: 4 $\mu$ s)	2.2	3.0	5.5	V
	Vdd4	f <sub>x</sub> = 8 MHz	High-speed mode (Instruction execution time: 2 $\mu$ s)	3.5	5.0	5.5	
Oscillation Frequency	fx			1.0	4.0	8.0	MHz
Operating Temperature	Ta			-40	+25	+85	°C
Low-Voltage Detector Circuit* (Mask Option)	Тсү	Ta = −10 to	o +85°C	8		32	μS

\*: Reset if the status of V<sub>DD</sub> = 0.8 to 2.2 V lasts for 1 ms or longer. Program hang-up does not occur even if the voltage drops, until the reset function is effected (when the RESET pin and WDOUT pin are connected). Some oscillators stop oscillating before the reset function is effected.



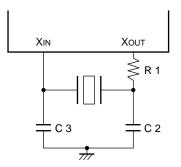
**Remark:** The region indicated by the broken line in the above figure is the guaranteed operating range in the high-speed mode.

System Clock Oscillator Circuit Characteristics ( $T_A = -40$  to  $+85^{\circ}C$ ,  $V_{DD} = 2.0$  to 5.5 V)

Resonator	Recommended Constants	ltem	Conditions	MIN.	TYP.	MAX.	Unit
	Xin Xout	Oscillation frequency (f <sub>x</sub> )* <sup>1</sup>		1.0	4.0	8.0	MHz
Ceramic		Oscillation stabilization time* <sup>2</sup>	After V <sub>DD</sub> reached MIN. in oscillation voltage range			4	ms

- \* 1: The oscillation frequency only indicates the oscillator characteristics.
- 2: The oscillation stabilization time is necessary for oscillation to be stabilized, after VDD application or STOP mode release.
- Caution: To use a system clock oscillator circuit, perform the wiring in the area enclosed by the dotted line in the above figure as follows, to avoid adverse wiring capacitance influences:
  - Keep wiring length as short as possible.
  - Do not cross a signal line with some other signal lines. Do not route the wiring in the vicinity of lines through which a large current flows.
  - Always keep the oscillator circuit capacitor ground at the same potential as GND. Do not ground the capacitor to a ground pattern, through which a large current flows.
  - Do not extract signals from the oscillator circuit.

External circuit example



## **Ceramic resonators**

Manufacturer	Product Name	Reco	mmended Constants			Oscillation Voltage Range		
		C1 (pF)	C2 (pF)	R1 (kΩ)	MIN. (V)	MAX. (V)		
Murata Mfg, Co., Ltd.	CSB1000J	100	100	4.7	2.0	5.5		
	CSA2.00MG	30	30	_	2.0	5.5		
	CSA4.00MG	30	30	-	2.0	5.5		
	CSA6.00MG	30	30	_	2.0	5.5		
	CSA8.00MTZ	30	30	_	2.1	5.5		
	CST2.00MG	_	-	_	2.0	5.5		
	CST4.00MGW	_	-	_	2.0	5.5		
	CST6.00MGW	_	-	-	2.0	5.5		
	CST8.00MTW	_	-	_	2.1	5.5		
Kyocela Corp.	KBR-1000Y/F	100	100	_	2.0	5.5		
	KBR-2.0MS	47	47	_	2.0	5.5		
	KBR-4.0MSA	33	33	_	2.0	5.5		
	KBR-4.0MKS/MWS	_	-	_	2.0	5.5		
	KBR-6.0MSA	33	33	_	2.2	5.5		
	KBR-6.0MKS/MWS	_	-	_	2.0	5.5		
	KBR-8.0M	33	33	_	2.2	5.5		
	PBRC2.00A	47	47	_	2.0	5.5		
	PBRC3.58A	33	33	-	2.0	5.5		
	PBRC4.00A	33	33	_	2.0	5.5		
	PBRC6.00A	33	33	_	2.0	5.5		
	PBRC8.00A	33	33	_	2.0	5.5		
TDK Corp.	FCR2.0M3	33	33	_	2.0	5.5		
	FCR2.0MC3	_	_	_	2.0	5.5		
	FCR4.0M5	33	33	_	2.0	5.5		
	FCR4.0MC5	_	-	_	2.0	5.5		
	CCR4.0MC3	_	-	-	2.0	5.5		
Matsushita Electronics Com-	EFOEC2004A4	_	_	_	2.0	5.5		
ponents Co., Ltd.	EFOEC4004A4	-	_	-	2.0	5.5		
	EFOEC6004A4	-	-	-	2.0	5.5		
	EFOEC8004A4	_	_	_	2.0	5.5		
	EFOEN2004A4	33	33	-	2.0	5.5		
	EFOEN4004A4	33	33	-	2.0	5.5		
	EFOEN6004A4	33	33	_	2.0	5.5		
	EFOEN8004A4	33	33	_	2.0	5.5		

# **DC Characteristics** (V<sub>DD</sub> = 2.0 to 5.5 V, $T_A = -40$ to $+85^{\circ}C$ )

Item	Symbol	I Conditions		MIN.	TYP.	MAX.	Ur
	VIH1	RESET, INT pin		0.8Vdd		Vdd	١
	Vih2	P0A, P0B		0.7Vdd		Vdd	١
High-Level Input Voltage	Vінз	P0E	$2.0 \text{ V} \leq \text{V}_{\text{DD}} < 3.0 \text{ V}$	VDD-0.3		Vdd	١
	Vih4	P0E	$3.0~\text{V} \leq \text{V}_{\text{DD}} \leq 5.5~\text{V}$	Vdd-0.5		Vdd	Ņ
	Vih5	Xin		0.8Vdd		Vdd	Ņ
	VIL1	RESET, INT pin		0		0.2Vdd	
	VIL2	P0A, P0B		0		0.3Vdd	,
High-Level Input Voltage Low-Level Input Voltage High-Level Input Leakage Current Low-Level Input Leakage Current High-Level Output Leakage Current Low-Level Output Leakage Current High-Level Input Current Low-Level Input Current High-Level Input Current Low-Level Input Current High-Level Output Current High-Level Output Current High-Level Output Voltage Low-Level Output Voltage	VIL3	P0E		0		0.35Vdd	
	VIL4	Xin		0		0.2Vdd	
High-Level Input Leakage Current	Іцн	INT, RESET, P0A, P0B, P0E	Vih = Vdd			3.0	μ
	ILIL1	INT	V1L = 0 V			-3.0	μ
Current	ILIL2	P0E	VIL = 0 V w/o pull-up resistor			-3.0	Ļ
High-Level Output Leakage Current	Ігон	<u>P0C, P0</u> D, P0E, WDOUT	Voh = Vdd			3.0	μ
	ILOL1	WDOUT	Vol = 0 V			-3.0	Ļ
Current	ILOL2	P0E	VoL = 0 V w/o pull-up resistor			-3.0	μ
High-Level Input Current	Ін	Xin	Vih = Vdd			20	Ļ
Low-Level Input Current	lı∟	Xin	VIL = 0 V			-20	μ
	Duu	RESET, POE	$V_{DD} = 3 \text{ V} \pm 10\%$	25	50	100	k
Internal Dull Lin Decistor	Rui	RESET, POE	$V_{DD} = 5 \text{ V} \pm 10\%$	25	50	100	k
Internal Pull-Op Resistor	Due	P0A, P0B	$V_{DD} = 3 \text{ V} \pm 10\%$	100	200	400	k
	Ru2	P0A, P0B	$V_{DD} = 5 \text{ V} \pm 10\%$	100	200	400	k
High-Level Output Current	Іон	REM	Vон = 1.0 V, Vdd = 3 V	-6.0	-13.0		n
High-Level Output Voltage	Vон	P0E, REM	Іон = -0.5 V mA	Vdd-0.3			
Low-Level Output Voltage	Vol1	<u>P0C, P0</u> D, REM, WDOUT	loL = 0.5 mA			0.3	
	Vol2	P0E	IoL = 1.5 mA			0.3	
Low-Level Input Voltage High-Level Input Leakage Current Low-Level Input Leakage Current High-Level Output Leakage Current Low-Level Output Leakage Current High-Level Input Current Low-Level Input Current Internal Pull-Up Resistor High-Level Output Current High-Level Output Current High-Level Output Voltage	Vdt1			0.8	1.6	2.4	
	Vdt2	$T_A = -10$ to +85°C		0.8	1.6	2.2	
Data Retension Voltage	Vddr	STOP mode		1.3			

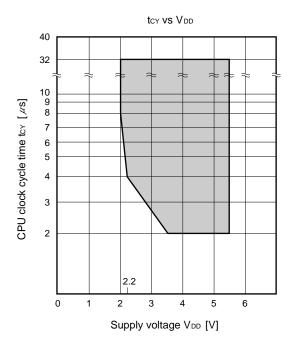
Item	Symbol		n-speed mode) $V_{DD} = 5 \text{ V}$ T mode $f_x = 8 \text{ MHz}$ $V_{DD} = 5 \text{ V}$ rating mode n-speed mode) $f_x = 4 \text{ MHz}$ $V_{DD} = 5 \text{ V}$ rating mode nary mode) $f_x = 4 \text{ MHz}$ $V_{DD} = 5 \text{ V}$ T mode $f_x = 4 \text{ MHz}$ $V_{DD} = 2 \text{ to}$ T mode $f_x = 4 \text{ MHz}$ $V_{DD} = 5 \text{ V}$ T mode $f_x = 4 \text{ MHz}$ $V_{DD} = 5 \text{ V}$ T mode $f_x = 1 \text{ MHz}$ $V_{DD} = 3 \text{ V}$ Nobelinespeed mode) $f_x = 1 \text{ MHz}$ $V_{DD} = 3 \text{ V}$ T mode $f_x = 1 \text{ MHz}$ $V_{DD} = 3 \text{ V}$ T mode $f_x = 1 \text{ MHz}$ $V_{DD} = 3 \text{ V}$ DP mode = -40 to +85°C) $V_{DD} = 5 \text{ V}$ DP mode $V_{DD} = 2 \text{ to}$ DP mode $V_{DD} = 5 \text{ V}$ DP mode $V_{DD} = 5  $		MIN.	TYP.	MAX.	Unit
	Idd1	Operating mode (high-speed mode)	f <sub>x</sub> = 8 MHz			2	4	mA
	IDD2	HALT mode	f <sub>x</sub> = 8 MHz	- VDD = 5 V ± 10%		0.9	2.4	mA
		Operating mode (high-speed mode)		$V_{DD} = 5 V \pm 10\%$		1.3	3.0	mA
				$V_{DD} = 3 \text{ V} \pm 10\%$		0.5	1.0	mA
	IDD3	Operating mode	$f_x = 4 \text{ MHz}$	$V_{DD} = 5 \text{ V} \pm 10\%$		1.0	2.0	mA
		(ordinary mode)		$V_{DD} = 3 V \pm 10\%$		0.4	0.8	mA
				V <sub>DD</sub> = 2 to 2.2 V		0.2	0.4	mA
		HALT mode		$V_{DD} = 5 V \pm 10\%$		0.8	1.8	mA
	IDD4		f <sub>x</sub> = 4 MHz	$V_{DD} = 3 V \pm 10\%$		0.3	0.6	mA
				V <sub>DD</sub> = 2 to 2.2 V		0.15	0.3	mA
Supply Current	IDD5	Operating mode (high-speed mode)	f <sub>x</sub> = 1 MHz	$V_{DD} = 3 V \pm 10\%$		0.25	0.5	mA
Supply Sullent				V <sub>DD</sub> = 2 to 2.2 V		0.15	0.3	mA
	DD6	HALT mode	f <sub>x</sub> = 1 MHz	$V_{DD} = 3 V \pm 10\%$		0.2	0.4	mA
				VDD = 2 to 2.2 V		0.1	0.2	mA
		STOP mode (T <sub>A</sub> = $-40$ to $+85^{\circ}$ C)		$V_{DD} = 5 V \pm 10\%$		1	30	μΑ
	Idd7			$V_{DD} = 3 V \pm 10\%$		1	20	μΑ
				V <sub>DD</sub> = 2 to 2.2 V		1	16	μA
		STOP mode		$V_{DD} = 5 V \pm 10\%$		1	20	μA
	IDD8	$(T_A = -20 \text{ to } +70^{\circ}\text{C})$	2)	$V_{DD} = 3 V \pm 10\%$		1	10	μA
				V <sub>DD</sub> = 2 to 2.2 V		1	8	μΑ
		STOP mode		$V_{DD} = 5 \text{ V} \pm 10\%$		1	5	μΑ
	IDD9	$(T_A = 25^{\circ}C)$		$V_{DD} = 3 V \pm 10\%$		1	5	μΑ
						1	5	μΑ

AC Characteristics (VDD = 2.0 to 5.5 V, TA = -40 to  $+85^{\circ}$ C)

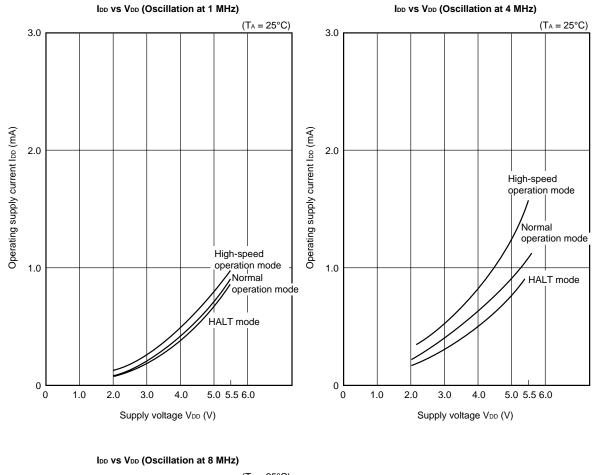
Item	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
CDU Clock Cycle Time*	tcy1	V <sub>DD</sub> = 3.5 to 5.5 V	1.99		32.2	μs
CPU Clock Cycle Time* (Instruction Execution Time)	tcy2	V <sub>DD</sub> = 2.2 to 5.5 V	3.98		32.2	μs
	tсүз		7.96		32.2	μs
INT High/Low Level Width	tioн, tiol	VDD = 4.5 to 5.5 V	10			μs
			50			μs
RESET Low Level Width	trsl	VDD = 4.5 to 5.5 V	10			μs
			50			μs

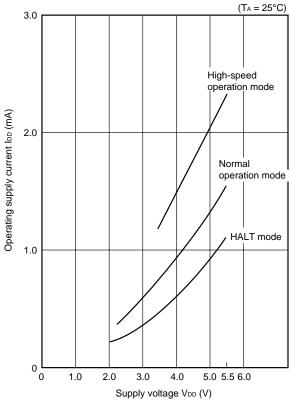
\*: The CPU clock cycle time (instruction execution time) is determined by the oscillation frequency of the oscillator connected and SYSCK (RF: address 02H) of the register file.

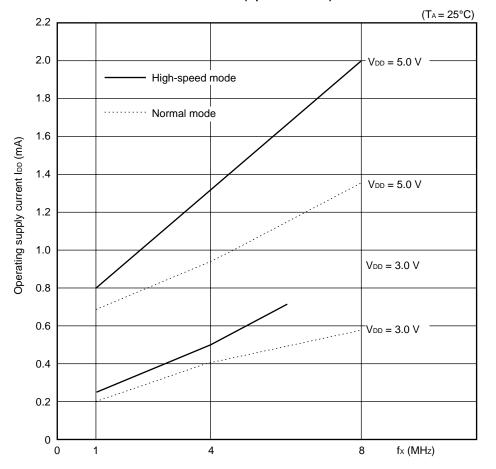
The figure on the right shows the CPU clock cycle time tcy vs. supply voltage VDD characteristics (refer to **4. CLOCK GENERATOR CIRCUIT**).



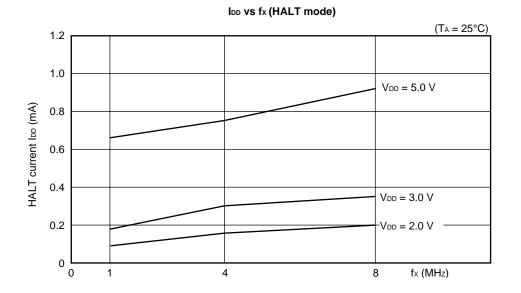
# 14. CHARACTERISTIC WAVEFORMS (REFERENCE VALUE)

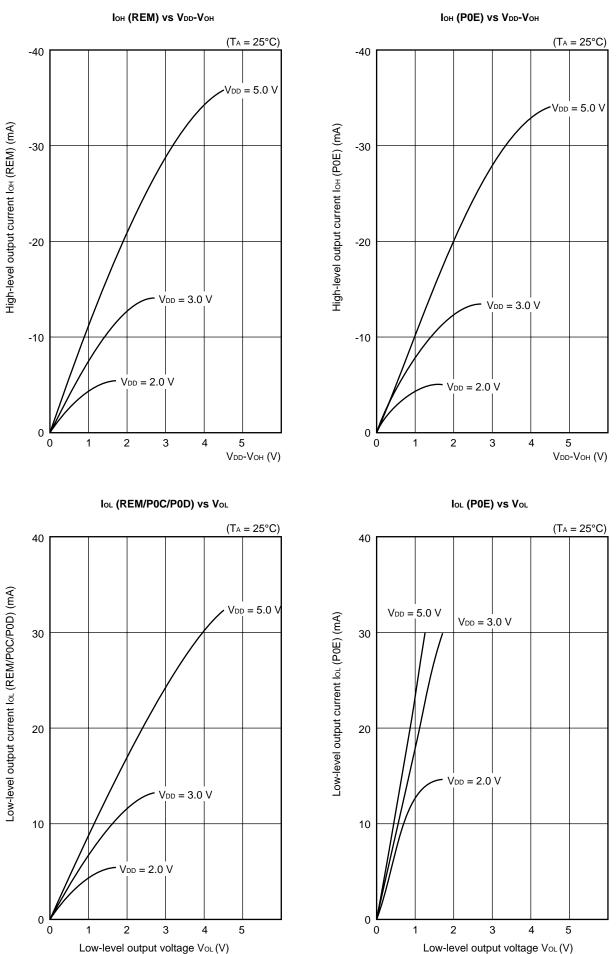




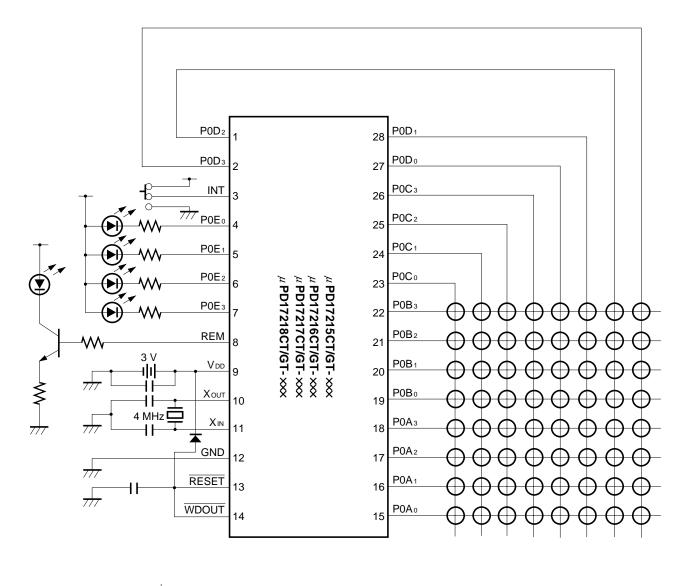


IDD vs fx (Operation mode)





# **15. APPLICATION CIRCUIT EXAMPLE**

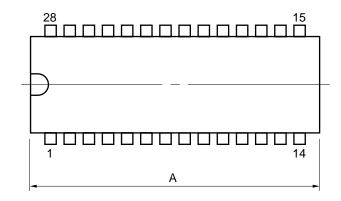


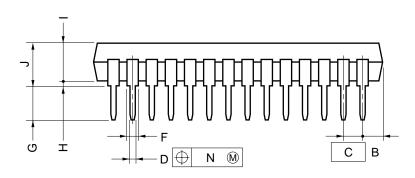


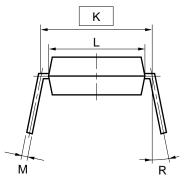
**Remark:** The RESET pin can be connected to a pull-up resistor by the mask option.

★ 16. PACKAGE DRAWINGS

# 28 PIN PLASTIC SHRINK DIP (400 mil)







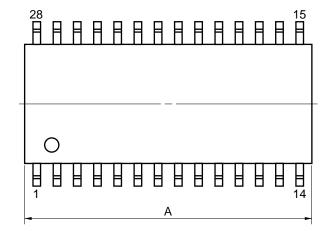
#### NOTES

1) Each lead centerline is located within 0.17 mm (0.007 inch) of its true position (T.P.) at maximum material condition.

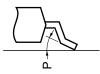
2) Item "K" to center of leads when formed parallel.

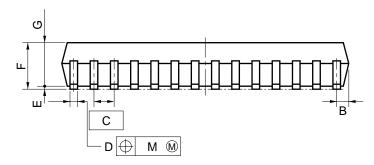
ITEM	MILLIMETERS	INCHES
А	28.46 MAX.	1.121 MAX.
В	2.67 MAX.	0.106 MAX.
С	1.778 (T.P.)	0.070 (T.P.)
D	0.50±0.10	$0.020^{+0.004}_{-0.005}$
F	0.85 MIN.	0.033 MIN.
G	3.2±0.3	0.126±0.012
Н	0.51 MIN.	0.020 MIN.
I	I 4.31 MAX. 0.170 MA	
J	5.08 MAX.	0.200 MAX.
К	10.16 (T.P.)	0.400 (T.P.)
L	8.6	0.339
М	$0.25^{+0.10}_{-0.05}$	$0.010^{+0.004}_{-0.003}$
N	0.17	0.007
R	0~15°	0~15°
		S28C-70-400B-1

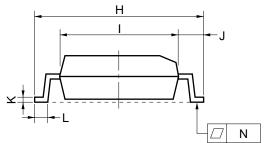
# 28 PIN PLASTIC SOP (375 mil)



detail of lead end







## NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES		
А	18.07 MAX.	0.712 MAX.		
В	0.78 MAX.	0.031 MAX.		
С	1.27 (T.P.)	0.050 (T.P.)		
D	$0.40^{+0.10}_{-0.05}$	$0.016^{+0.004}_{-0.003}$		
E	0.1±0.1	0.004±0.004		
F	2.9 MAX.	0.115 MAX.		
G	2.50 0.098			
Н	10.3±0.3	$0.406\substack{+0.012\\-0.013}$		
I	7.2	0.283		
J	1.6	0.063		
К	$0.15^{+0.10}_{-0.05}$	$0.006^{+0.004}_{-0.002}$		
L	0.8±0.2	0.031+0.009 -0.008		
М	0.12	0.005		
Ν	0.15	0.006		
Р	3°+7° -3°	3° <sup>+7°</sup> -3°		
		228GM-50-375B-3		

P28GM-50-375B-3

\*

# 17. RECOMMENDED SOLDERING CONDITIONS

For the  $\mu$ PD17215, 17216, 17217, and 17218, soldering must be performed under the following conditions. For details of recommended conditions for surface mounting, refer to information document "Semiconductor device mounting technology manual" (C10535E).

For other soldering methods, please consult with NEC personnel.

#### Table 17-1 Soldering Conditions of Surface Mount Tye

μPD17215GT-xxx:	28-pin plastic SOP (375 mil)
μPD17216GT-xxx:	28-pin plastic SOP (375 mil)
μPD17217GT-xxx:	28-pin plastic SOP (375 mil)
μPD17218GT-xxx:	28-pin plastic SOP (375 mil)

Soldering Method	Soldering Conditions	Symbol
Infrated Reflow	Package peak temperature: 235°C, Time: 30 seconds max. (210°C min.), Number of times: 2 max., Days: 7 days* (after that, prebaking is necessary for 20 hours at 125°C) <cautions> Products other than those supplied in thermal-resistant tray (magazine, taping, and non-thermal-resistant tray) cannot be baked in their packs.</cautions>	IR35-207-2
VPS	Package peak temperature: 215°C, Time: 40 seconds max. (210°C min.), Number of times: 2 max., Days: 7 days* (after that, prebaking is necessary for 20 hours at 125°C) <cautions> Products other than those supplied in thermal-resistant tray (magazine, taping, and non-thermal-resistant tray) cannot be baked in their packs.</cautions>	VP15-207-2
Partial Heating	Pin temperature: 300°C max., Time: 3 seconds max. (per side of device)	_

\*: The number of days the device can be stored after the dry pack was opened, under storage conditions of 25°C and 65% RH max.

Caution: Do not use two or more solderong methods in combination (except the partial heating method).

#### Table 17-2 Soldering Conditions of Through-Hole Tye

μPD17215CT-xxx:	28-pin plastic shrink DIP (400 mil)
μPD17216CT-xxx:	28-pin plastic shrink DIP (400 mil)
μPD17217CT-xxx:	28-pin plastic shrink DIP (400 mil)
μPD17218CT-xxx:	28-pin plastic shrink DIP (400 mil)

Soldering Method	Soldering Conditions
Wave Soldering (Only for pins)	Solder bath temperature: 260°C max., Time: 10 seconds max.
Partial Heating	Pin temperature: 300°C max., Time: 3 seconds max. (per pin)

Caution: The wave solding must be performed at the lead part only. Note that the solder must not be directly contacted to the package body.

## APPENDIX A. DIFFERENCES AMONG $\mu$ PD17215, 17216, 17217, 17218 AND $\mu$ PD17P218

 $\mu$ PD17P218 is equipped with PROM to which data can be written by the user instead of the internal mask ROM (program memory) of the  $\mu$ PD17218.

Table A-1 shows the differences between the  $\mu$ PD17215, 17216, 17217, 17218 and  $\mu$ PD17P218.

The differences among these five models are the program memory and mask option, and their CPU functions and internal hardware are identical. Therefore, the  $\mu$ PD17P218 can be used to evaluate the program developed for the  $\mu$ PD17215, 17216, 17217, and 17218 system. Note, however, that some of the electrical specifications such as supply current and low-voltage detection voltage of the  $\mu$ PD17P218 are different from those of the  $\mu$ PD17215, 17216, 17217, and 17218.

Product Name Item	μPD17P218	μPD17215 μPD17216		μPD17217	μPD17218	
Program Memory	One-time PROM Mask ROM			ROM		
riogram memory	16 K bytes (8192 × 16) (0000H-1FFFH)	4 K bytes (2048 × 16) (0000H-07FFH)	8 K bytes (4096 × 16) (0000H-0FFFH)	12 K bytes (6144 × 16) (0000H-17FFH)	16 K bytes (8192 × 16) (0000H-1FFFH)	
Data Memory	$223 \times 4$ bits	111 ×	4 bits	223 ×	4 bits	
Pull-Up Resistor of RESET Pin	Provided		Any (ma	sk option)		
Low-Voltage Detector Circuit *	Provided	Any (mask option)				
VPP Pin, Operation Mode Select Pin	Provided	Not provided				
Instruction Execution Time		2 $\mu$ s (8 MHz ceramic oscillator: in high-speed mode) 4 $\mu$ s (4 MHz ceramic oscillator: in high-speed mode) 16 $\mu$ s (1 MHz ceramic oscillator: in high-speed mode)				
Operation When P0C, P0D Are Standby		Retain output le	vel immediately befo	ore standby mode		
Supply Voltage		VDD = 2.2 to 5.5	V (at fx = 4 MHz, in	high-speed mode)		
Package			in plastic SOP (375 plastic shrink DIP (4			

Table A-1 Differences among  $\mu$ PD17215, 17216, 17217, 17218 and  $\mu$ PD17P218

\*: Although the circuit configuration is identical, its electrical characterisitcs differ depending on the product.

# APPENDIX B. FUNCTIONAL COMPARISON OF $\mu$ PD17215 SUBSERIES RELATED PRODUCTS

Item	Product Name	μPD17201A	D17201A μPD17207 μPD17202A μPD17215		μPD17216	μPD17217	μPD17218	
ROM Capacit	ROM Capacity (Bit)		4096 × 16	2048 × 16		4096 × 16	6144 × 16	8192 × 16
RAM Capacity	y (Bit)	336 × 4		112 × 4	111	111 × 4 223 × 4		× 4
LCD Controller/Driver		136 segments max.		96 segments max.	Not provided			
Infrared Remo	ote Controller rator (REM)	LED output is high-actives		LED output is low- actives	Internal (no LED output)			
I/O Ports		19 li	nes	16 lines		20 I	ines	
External Inter	rupt (INT)	1 li (rising-edge			1 line (rising-e	dge, falling-eo	dge, detection)	)
Analog Input		4-channels	(8-bit A/D)			Not provided		
Timer		2-channels 8-bit timer Watch timer			2-channels 8-bit timer Basic interval timer			
Watchdog Tin	ner	Internal (WDOUT output)						
Low-Voltage Detector Circuit*		Not provided			Internal (WDOUT output)			
Serial Interfac	ce	1-channel			Not provided			
Stack		5 levels (3 levels for multiplexed interrupt)						
Instruction Execution Time	Main System Clock	4 μs (4 MHz: with ceramic or crys oscillator)		rystal	<ul> <li>2 μs (8 MHz ceramic oscillator: In high-speed mode)</li> <li>4 μs (4 MHz ceramic oscillator: In high-speed mode)</li> <li>16 μs (1 MHz ceramic oscillator: In high-speed mode)</li> </ul>			
	Subsystem Clock	488 ms (32.768 kHz: with oscillator)		crystall	Not provided			
Supply Voltage (With Subsystem Clock)		$V_{DD}$ = 2.2 to 5.5 V ( $V_{DD}$ = 2.0 to 5.5 V)			V <sub>DD</sub> = 2.2 to 5.5 V			
Standby Function		STOP, HALT						
Package		80-pin plastic QFP 64-pin plastic QFF		64-pin plastic QFP	28-pin plastic SOP 28-pin plastic shrink DIP			
One-Time PR	OM Products	μPD17	7P207	μPD17P202A		µPD1	7P218	
		, p. D	0.			μ. Βι		

\*: Note that although all the prodcts have the same circuit construction, the electrical specifications differ dependant on each product.

# APPENDIX C. DEVELOPMENT TOOLS

To develop the programs for the  $\mu$ PD17215 subseries, the following development tools are available:

#### Hardware

Name	Remarks
In-Circuit Emulator (IE-17K, IE-17K-ET *1, EMU-17K *2	<ul> <li>IE-17K, IE-17K-ET, and EMU-17K are the in-circuit emulators used in common with the 17K series microcomputer.</li> <li>IE-17K and IE-17K-ET are connected to a PC-9800 series or IBM PC/AT<sup>™</sup> as the host machine with RS-232C. EMU-17K is inserted into the expansion slot of a PC-9800 series. By using these in-circuit emulators with a system evaluation board corresponding to the microcomputer, the emulators can emulate the microcomputer. A higher level debugging environment can be provided by using man-machine interface <i>SIMPLEHOST<sup>™</sup></i>. EMU-17K also has a function by which you can check the contents of data memory real-time.</li> </ul>
SE Board (SE-17215)	This is an SE board for $\mu$ PD17215 subseries. It can be used alone to evaluate a system or in combination with an in-circuit emulator for debugging.
Emulation Probe (EP-17K28CT)	EP-17K28CT is an emulation probe for 17K series 28-pin shrink DIP (400mil).
Emulation Probe (EP-17K28GT)	EP-17K28GT is an emulation probe for 17K series 28-pin SOP (375 mil). When used with EV-9500GT-28 <sup>Note 3</sup> , it connects an SE board to the target system.
Conversion Adapter (EV-9500GT-28 * <sup>3</sup> )	EV-9500GT-28 is a conversion adapter for 28-pin SOP (375 mil) and is used to connect EP-17K28GT to the target system.
PROM Programmer (AF-9703 * <sup>4</sup> , AF-9704 * <sup>4</sup> , AF-9705 * <sup>4</sup> , AF-9706 * <sup>4</sup> )	AF-9703, AF-9704, AF-9705, and AF-9706 are PROM programmers corresponding to $\mu$ PD17P218. By connecting program adapter AF-9808J or AF-9808H to this PROM programmer, $\mu$ PD17P218 can be programmed.
Program Adapter (AF-9808J *4, AF-9808H *4)	AF-9808J and AF-9808H are adapters that is used to program $\mu$ PD17P218CT and $\mu$ PD17P218GT respectively, and is used in combination with AF-9703, AF-9704, AF-9705, or AF-9706.

- \*1: Low-cost model: External power supply type
- 2: This is a product from I.C Corp. For details, consult I.C Corp. (Tel: Tokyo 03-3447-3793).
- 3: Two EV-9500GT-28s are supplied with the EP-17K28GT. Five EV-9500GT-28s are optionally available as a set.
- 4: These are products from Ando Electric Co., Ltd. For details, consult Ando Electric Co., Ltd. (Tel: Tokyo 03-3733-1163).

#### Software

Name	Outline	Host Machine	OS I	Media	Supply	Order Code
	AS17K is an assembler common to the 17K series	PC-9800	MS-DOS <sup>™</sup>		5" 2HD	μ\$5A10A\$17K
17K Series Assembler	products. When developing the program of the $\mu$ PD17215	series			3.5" 2HD	μ\$5A13A\$17K
(AS17K)	subseries, AS17K is used in combination with a device file (AS17215, AS17216, AS17217, or AS17218).	IBM PC/AT	DC D	PC DOS <sup>TM</sup>		μ\$7B10A\$17K
	01 AS 172 16).	IBIVI PC/AT	FUL			μ\$7B13A\$17K
	AS17215, AS17216, AS17217, and AS17218 are device files for $\mu$ PD17215, 17216, 17217, and 17218 respectirely, and are used in combination with an assembler for the 17K series (AS17K).	PC-9800	MS-DOS		5" 2HD	μS5A10AS17215 *
Device File ( AS17215 AS17216 AS17217 ( AS17218 )		series			3.5" 2HD	μS5A10AS17215 *
			PC DOS		5" 2HC	μS5A10AS17215 *
		IBM PC/AT			3.5" 2HC	μS5A10AS17215 *
	SIMPLEHOST is a software	PC-9800	MS-DOS		5" 2HD	μ\$5A10ΙΕ17Κ
Support Software ( <i>SIMPLE- HOST</i> )	package that enables man- machine interface on the Windows <sup>TM</sup> when a program is developed by using an in-circuit emulator and a personal computer.	series	M3-D03	Windows	3.5" 2HD	μ\$5A13IE17K
					5" 2HC	μ\$7B10IE17K
		IBM PC/AT	PC DOS		3.5" 2HC	μ\$7B13IE17K

\*:  $\mu$ S××××AS17215 includes AS17215, AS17216, AS17217, and AS17218.

**Remark:** The corresponding OS versions are as follows:

OS	Version
MS-DOS	Ver. 3.30 to Ver. 5.00A *
PC DOS	Ver. 3.1 to Ver. 5.0 *
Windows	Ver. 3.0 to Ver. 3.1

\*: Ver. 5.00/5.00A of MS-DOS and Ver. 5.0 of PC DOS have a task swap function, but this function cannot be used with this software.

[MEMO]

## - NOTES FOR CMOS DEVICES —

### **①** PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

#### Note:

Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

#### ② HANDLING OF UNUSED INPUT PINS FOR CMOS

#### Note:

No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

## **③** STATUS BEFORE INITIALIZATION OF MOS DEVICES

#### Note:

Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

# **Regional Information**

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- · Device availability
- Ordering information
- Product release schedule
- · Availability of related technical literature
- Development environment specifications (for example, specifications for third-party tools and components, host computers, power plugs, AC supply voltages, and so forth)
- Network requirements

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